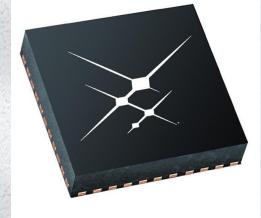


# SI5394C-A-GM Datasheet

www.digi-electronics.com



DiGi Electronics Part Number	SI5394C-A-GM-DG
Manufacturer	Skyworks Solutions Inc.
Manufacturer Product Number	SI5394C-A-GM
Description	SINGLE PLL JITTER ATTENUATOR WIT
Detailed Description	IC

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## Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
SI5394C-A-GM	Skyworks Solutions Inc.
Series:	Product Status:
*	Active
DiGi-Electronics Programmable:	Base Product Number:
Not Verified	SI5394

## **Environmental & Export classification**

Moisture Sensitivity Level (MSL):	ECCN:
2 (1 Year)	EAR99
HTSUS:	
8542.39.0001	



## Si5395/94/92 Data Sheet

#### 12-Channel, Any-Frequency, Any-Output Jitter Attenuator/Clock Multiplier with Ultra-Low Jitter

The Si5395/94/92 Jitter attenuators combine fourth-generation DSPLL<sup>™</sup> and Multi-Synth<sup>™</sup> technologies to deliver ultra-low jitter (69 fs) for high performance applications like 56G SerDes. They are used in applications that demand the highest level of integration and jitter performance. All PLL components are integrated on-chip, eliminating the risk of noise coupling associated with discrete solutions. Device grades J/K/L/M/E have an integrated reference to save board space, improve system reliability and reduces the effect of acoustic emissions noise caused by temperature ramps. Grades A/B/C/D/P use an external crystal (XTAL) or crystal oscillator (XO) reference.

The Si5395/94/92 support free-run, synchronous and holdover modes as well as enhanced hitless switching, minimizing the phase transients associated when switching between input clocks. These devices are programmable via a serial interface with in-circuit programmable non-volatile memory (NVM) so they always power up with a known frequency configuration. Programming the Si5395/94/92 is easy with Skyworks' ClockBuilder<sup>™</sup> Pro software. Factory preprogrammed devices are also available.

For more information, visit https://www.skyworksinc.com/en/Products/Timing page.

#### Applications:

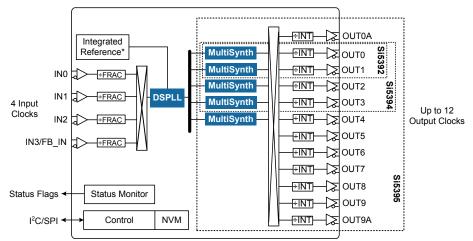
- · 56G/112G PAM4 SerDes clocking
- · OTN muxponders and transponders
- 10/40/100/200/400G networking line cards
- 10/40/100/400 GbE Synchronous Ethernet (ITU-T G.8262)
- · Medical imaging
- · Test and measurement

#### KEY FEATURES

- Generates any combination of output frequencies from any input frequency
- · Ultra low phase jitter:
  - · 69 fs RMS (Grade P)
  - 71 fs RMS (Grade E)
  - 85 fs RMS (integer mode)
  - 100 fs RMS (fractional mode)
- Enhanced hitless switching minimizes output phase transients (0.2 ns typ)
- Input frequency range
  - Differential: 8 kHz to 750 MHz
  - LVCMOS: 8 kHz to 250 MHz
- Output frequency range
  - Differential: 100 Hz to 1028 MHz
  - LVCMOS: 100 Hz to 250 MHz
- Meets G.8262, E.8262.1 EEC Standards
- · Status monitoring
- Si5395: 4 input, 12 output (64-QFN/LGA)
- Si5394: 4 input, 4 output (44-QFN/LGA)
- Si5392: 4 input, 2 output (44-QFN/LGA)
- External reference: Grades A/B/C/D/P
- Integrated reference: Grades J/K/L/M/E

1

Drop-in compatible with Si5345/44/42



\*Only for Si539x J/K/L/M/E grades. Si539x A/B/C/D/P grades have external reference (XTAL or XO)

SI5394C-A-GM Skyworks Solutions Inc. SINGLE PLL JITTER ATTENUATOR WIT Si5395/94/92 Data Sheet • Features List

#### 1. Features List

The Si5395/94/92 features are listed below:

- Generates any output frequency in any format from any input frequency
- External XTAL or XO reference (A/B/C/D/P)
- Integrated reference (J/K/L/M/E)
- Ultra-low phase jitter of 69 fs (P-Grade)
- · Dynamic phase adjust
- Input frequency range
  - Differential: 8 kHz–750 MHz
  - LVCMOS: 8 kHz-250 MHz
- Output frequency range
  - Differential: 100 Hz to 1028 MHz
  - LVCMOS: 100 Hz to 250 MHz
- Programmable jitter attenuation bandwidth: 0.1 Hz to 4 kHz
- · Meets requirements of:
  - ITU-T G.8262 (SyncE) EEC Options 1 and 2
  - ITU-T G.8262.1 (Enhanced SyncE) eEEC
- Highly configurable outputs compatible with LVDS, LVPECL, LVCMOS, CML, and HCSL with programmable signal amplitude
- Status monitoring (LOS, OOF, LOL)
- Enhanced hitless switching for 8 kHz, 19.44 MHz, 25 MHz inputs and other frequencies
- · Locks to gapped clock inputs
- · Free-run and holdover modes
- Drop-in compatible with Si5345/44/42

- · Optional zero delay mode
- · Fast-lock acquisition for low nominal bandwidths
- Independent Frequency-on-the fly for each MultiSynth
- · DCO mode: as low as 0.001 ppb step size
- Core voltage
  - V<sub>DD</sub>: 1.8 V ±5%
  - V<sub>DDA</sub>: 3.3 V ±5%
- · Independent output clock supply pins
  - 3.3 V, 2.5 V, or 1.8 V
- Serial interface: I<sup>2</sup>C or SPI
- · In-circuit programmable with non-volatile OTP memory
- ClockBuilder Pro software simplifies device configuration

2

- Si5395: 4 input, 12 output
  - Grade A/B/C/D/P: 64-QFN 9×9 mm
  - Grade J/K/L/M/E: 64-LGA 9x9 mm
- Si5394: 4 input, 4 output
  - Grade A/B/C/D/P: 44-QFN 7×7 mm
  - Grade J/K/L/M/E: 44-LGA 7x7 mm
- Si5392: 4 input, 2 output
  - Grade A/B/C/D/P: 44-QFN 7×7 mm
  - Grade J/K/L/M/E: 44-LGA 7x7 mm
- Temperature range: -40 to +85 °C
- · Pb-free, RoHS-6 compliant

#### 2. Related Documents

#### Table 2.1. Related Documentation and Software

Document/Resource	Description/URL
Si5395/94/92 Family Reference Manual	https://www.skyworksinc.com/-/media/Skyworks/SL/docu- ments/public/reference-manuals/si5395-94-92-family.pdf
Crystal Reference Manual (Grades A/B/C/D/P only)	https://www.skyworksinc.com/-/media/Skyworks/SL/docu- ments/public/reference-manuals/si534x-8x-9x-recommended- crystals-rm.pdf
UG387: Si5392 Evaluation Board User's Guide	https://www.skyworksinc.com/-/media/Skyworks/SL/docu- ments/public/user-guides/ug387-si5392-evb.pdf
UG334: Si5394 Evaluation Board User's Guide	https://www.skyworksinc.com/-/media/Skyworks/SL/docu- ments/public/user-guides/ug334-si5394evb.pdf
UG335: Si5395 Evaluation Board User's Guide	https://www.skyworksinc.com/-/media/Skyworks/SL/docu- ments/public/user-guides/ug335-si5395evb.pdf
AN1151: Using the Si539x in 56G SerDes Applications	https://www.skyworksinc.com/-/media/Skyworks/SL/docu- ments/public/application-notes/an1151-using-si539x.pdf
AN1155: Differences between Si5342-47 and Si5392-97	https://www.skyworksinc.com/-/media/Skyworks/SL/docu- ments/public/application-notes/an1151-using-si539x.pdf
AN1178: Frequency-On-the-Fly for Skyworks Jitter Attenuators and Clock Generators	https://www.skyworksinc.com/-/media/Skyworks/SL/docu- ments/public/application-notes/an1178-frequency-otf-jitter-atten- clock-gen.pdf
Quality and Reliability	https://www.skyworksinc.com/Quality
Development Kits	https://www.skyworksinc.com/en/Products/Timing
ClockBuilder Pro (CBPro) Software	https://www.skyworksinc.com/en/Application-Pages/Clockbuilder- Pro-Software

#### 3. Ordering Guide

Ordering Part Number (OPN)	Number of Input/Output Clocks	Output Clock Frequency Range (MHz)	Supported Frequency Synthesis Modes	Package	Reference	
Si5395						
Si5395A-A-GM <sup>1, 2</sup>		0.0001 to 1028 MHz	Integer and Fractional			
Si5395B-A-GM <sup>1, 2</sup>		0.0001 to 350 MHz	Integer and Fractional			
Si5395C-A-GM <sup>1, 2</sup>	4/12	0.0001 to 1028 MHz	Integer Only	64-QFN 9×9 mm	External	
Si5395D-A-GM <sup>1, 2</sup>		0.0001 to 350 MHz	Integer Only	9×9 mm		
Si5395P-A-GM <sup>1, 2</sup>		Up to 3 domains (Section 4.9.2 Grades P and E)	Precision Calibration			
Si5394			·		1	
Si5394A-A-GM <sup>1, 2</sup>		0.0001 to 1028 MHz	Integer and Freetienel			
Si5394B-A-GM <sup>1, 2</sup>		0.0001 to 350 MHz	Integer and Fractional	 44-QFN 7×7 mm		
Si5394C-A-GM <sup>1, 2</sup>	4/4	0.0001 to 1028 MHz	Integer Only		External	
Si5394D-A-GM <sup>1, 2</sup>		0.0001 to 350 MHz			/ ~ / 11111	
Si5394P-A-GM <sup>1, 2</sup>		Up to 2 domains (Section 4.9.2 Grades P and E)	Precision Calibration			
Si5392		1				
Si5392A-A-GM <sup>1, 2</sup>		0.0001 to 1028 MHz	Integer and Fractional			
Si5392B-A-GM <sup>1, 2</sup>		0.0001 to 350 MHz	<ul> <li>Integer and Fractional</li> </ul>			
Si5392C-A-GM <sup>1, 2</sup>	4/2	0.0001 to 1028 MHz	Integer Only	44-QFN		External
Si5392D-A-GM <sup>1, 2</sup>		0.0001to 350 MHz	Integer Only	7×7 mm		
Si5392P-A-GM <sup>1, 2</sup>		1 domain (Section 4.9.2 Grades P and E)	Precision Calibration			
Si5395/94/92 Evaluati	ion Board		·			
Si5395A-A-EVB	12-output	Any-frequency, any Output	_	64-QFN EVB	_	
Si5395P-A-EVB	12-output	Low jitter clocks for 56G PAM4 SerDes	_	64-QFN EVB	_	
Si5394A-A-EVB	4-output	Any-frequency, any Output	_	44-QFN EVB	_	
Si5394P-A-EVB	4-output	Low jitter clocks for 56G PAM4 SerDes	_	44-QFN EVB	_	

1. Add an R at the end of the OPN to denote tape and reel ordering options.

2. Custom, factory preprogrammed devices are available. Ordering part numbers are assigned by Skyworks and the ClockBuilder Pro software utility. Custom part number format is "Si5395A-Axxxxx-GM" where "xxxxx" is a unique numerical sequence representing the preprogrammed configuration.

4

Ordering Part Number (OPN)	Number of Input/Output Clocks	Output Clock Frequency Range (MHz)	Supported Frequency Synthesis Modes	Package	Reference
Si5395			L		
Si5395J-A-GM <sup>1, 2</sup>		0.0001 to 1028 MHz	Integer and Exectional		
Si5395K-A-GM <sup>1, 2</sup>		0.0001 to 350 MHz	Integer and Fractional		
Si5395L-A-GM <sup>1, 2</sup>	4/12	0.0001 to 1028 MHz	Integer Only	64-LGA	Internal
Si5395M-A-GM <sup>1, 2</sup>		0.0001 to 350 MHz	Integer Only	9×9 mm	
Si5395E-A-GM <sup>1, 2</sup>		Up to 3 domains (Section 4.9.2 Grades P and E)	Precision Calibration		
Si5394					
Si5394J-A-GM <sup>1, 2</sup>		0.0001 to 1028 MHz	Integer and Fractional		
Si5394K-A-GM <sup>1, 2</sup>		0.0001 to 350 MHz	Integer and Fractional		
Si5394L-A-GM <sup>1, 2</sup>	4/4	0.0001 to 1028 MHz	late see Oaks	44-LGA	Internal
Si5394M-A-GM <sup>1, 2</sup>		0.0001 to 350 MHz	Integer Only	7×7 mm	
Si5394E-A-GM <sup>1, 2</sup>		Up to 2 domains (Section 4.9.2 Grades P and E)	Precision Calibration		
Si5392					1
Si5392J-A-GM <sup>1, 2</sup>		0.0001 to 1028 MHz	Integer and Freetienel		
Si5392K-A-GM <sup>1, 2</sup>	4/2	0.0001 to 350 MHz	Integer and Fractional		
Si5392L-A-GM <sup>1, 2</sup>		0.0001 to 1028 MHz	Integer Only	44-LGA	Internal
Si5392M-A-GM <sup>1, 2</sup>		0.0001to 350 MHz	Integer Only	7×7 mm	
Si5392E-A-GM <sup>1, 2</sup>		1 domain (Section 4.9.2 Grades P and E)	Precision Calibration		
Si5395/94/92 Evaluat	ion Board				
Si5395J-A-EVB	12-output	Any-frequency, any Output	_	64-LGA EVB	_
Si5395E-A-EVB	12-output	Low jitter clocks for 56G PAM4 SerDes	_	64-LGA EVB	_
Si5394J-A-EVB	4-output	Any-frequency, any Output	_	44-LGA EVB	_
Si5394E-A-EVB	4-output	Low jitter clocks for 56G PAM4 SerDes	_	44-LGA EVB	_
Si5392J-A-EVB	2-output	Any-frequency, any Output	_	44-LGA EVB	_
Si5392E-A-EVB	2-output	Low jitter clocks for 56G PAM4 SerDes	_	44-LGA EVB	_

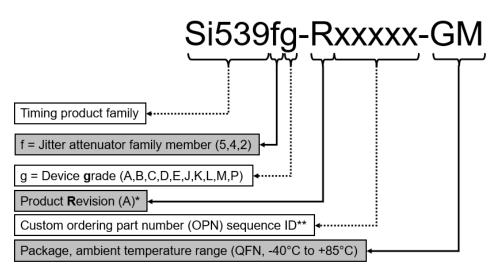
Table 3.2. Si5395/4/2 J/K/L/M/E Ordering guide (Integrated Reference)

SI5394C-A-GM Skyworks Solutions Inc. SINGLE PLL JITTER ATTENUATOR WIT Si5395/94/92 Data Sheet • Ordering Guide

Ordering Part Number (OPN)	Number of Input/Output Clocks	Output Clock Frequency Range (MHz)	Supported Frequency Synthesis Modes	Package	Reference
-------------------------------	-------------------------------------	---------------------------------------	--	---------	-----------

#### Notes:

- 1. Add an R at the end of the OPN to denote tape and reel ordering options.
- 2. Custom, factory preprogrammed devices are available. Ordering part numbers are assigned by Skyworks and the ClockBuilder Pro software utility. Custom part number format is "Si5395J-Axxxxx-GM" where "xxxxx" is a unique numerical sequence representing the preprogrammed configuration.



\*See Ordering Guide table for current product revision.

\*\* (Optional) 5 digits; assigned by ClockBuilder Pro for Custom, factory-preprogrammed OPN devices only;

(The "xxxxx" field is not included for "Base" OPNs).

Figure 3.1. Ordering Part Number Fields

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#### 4. Functional Description

The Si5392-95's internal DSPLL provides jitter attenuation and any-frequency multiplication of the selected input frequency. Fractional input dividers (P) allow the DSPLL to perform hitless switching between input clocks (INx) that are fractionally related. Input switching is controlled manually or automatically using an internal state machine. The oscillator circuit (OSC) provides a frequency reference which determines output frequency stability and accuracy while the device is in free-run or holdover mode. The high-performance MultiSynth dividers (N) generate integer or fractionally related output frequencies for the output stage. A crosspoint switch connects any of the MultiSynth generated frequencies to any of the outputs. Additional integer division (R) determines the final output frequency.

#### 4.1 Frequency Configuration

The frequency configuration of the DSPLL is programmable through the serial interface and can also be stored in non-volatile memory. The combination of fractional input dividers ( $P_n/P_d$ ), fractional frequency multiplication ( $M_n/M_d$ ), fractional output MultiSynth division ( $N_n/N_d$ ), and integer output division ( $R_n$ ) allows the generation of virtually any output frequency on any of the outputs. All divider values for a specific frequency plan are easily determined using the ClockBuilder Pro utility.

#### 4.2 DSPLL Loop Bandwidth

The DSPLL loop bandwidth determines the amount of input clock jitter attenuation. Register configurable DSPLL loop bandwidth settings in the range of 0.1 Hz to 4 kHz are available for selection for Grade A/B/C/D. Since the loop bandwidth is controlled digitally, the DSPLL will always remain stable with less than 0.1 dB of peaking regardless of the loop bandwidth selection. For grade P and E devices, the DSPLL bandwidth is fixed at 100 Hz.

#### 4.3 Fastlock Feature

Selecting a low DSPLL loop bandwidth (e.g. 0.1 Hz) will generally lengthen the lock acquisition time. The fastlock feature allows setting a temporary Fastlock Loop Bandwidth that is used during the lock acquisition process. Higher fastlock loop bandwidth settings will enable the DSPLLs to lock faster. Fastlock Loop Bandwidth settings of in the range of 100 Hz to 4 kHz are available for selection. The DSPLL will revert to its normal loop bandwidth once lock acquisition has completed.

#### 4.4 Modes of Operation

Once initialization is complete the DSPLL operates in one of four modes: Free-run Mode, Lock Acquisition Mode, Locked Mode, or Holdover Mode. A state diagram showing the modes of operation is shown in the figure below. The following sections describe each of these modes in greater detail.

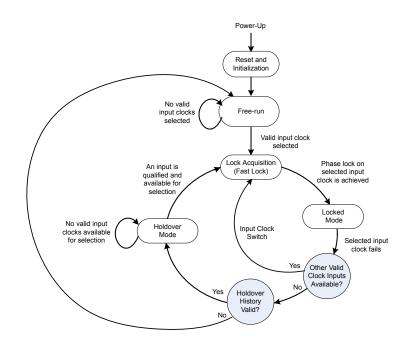


Figure 4.1. Modes of Operation

#### 4.4.1 Initialization and Reset

Once power is applied, the device begins an initialization period, downloads default register values and configuration data from NVM, and performs other initialization tasks. To communicate with the device through the serial interface, wait until the initialization period is complete. No clocks will be generated until the initialization is complete.

Clocks that feature the integrated crystal may require a slightly longer settling time compared to the external crystal device. See the Reference Manual for more details.

Two types of resets are available. A hard reset is functionally similar to a device power-up. All registers will be restored to the values stored in NVM and all circuits including the serial interface will be restored to their initial state. A hard reset is initiated using the RSTb pin or by asserting the hard reset register bit.

A soft reset bypasses the NVM download. It is used to initiate register configuration changes.

#### 4.4.2 Freerun Mode

The DSPLL will automatically enter freerun mode once power is applied to the device and initialization is complete. The frequency accuracy of the generated output clocks in freerun mode is entirely dependent on the frequency accuracy of the external crystal or reference clock on the XA/XB pins. For example, if the crystal frequency is ±100 ppm, then all the output clocks will be generated at their configured frequency ±100 ppm in freerun mode. Any drift of the crystal frequency will be tracked at the output clock frequencies. A TCXO or OCXO is recommended for applications that need better frequency accuracy and stability while in freerun or holdover modes.

#### 4.4.3 Lock Acquisition Mode

The device monitors all inputs for a valid clock. If at least one valid clock is available for synchronization, the DSPLL will automatically start the lock acquisition process. If the fast lock feature is enabled, the DSPLL will acquire lock using the Fastlock Loop Bandwidth setting and then transition to the DSPLL Loop Bandwidth setting when lock acquisition is complete. During lock acquisition the outputs will generate a clock that follows the VCO frequency change as it pulls in to the input clock frequency.

#### 4.4.4 Locked Mode

Once locked, the DSPLL will generate output clocks that are both frequency and phase locked to their selected input clocks. At this point, any XTAL frequency drift will not affect the output frequency. A loss of lock pin (LOL) and status bit indicate when lock is achieved. See 4.8.4 LOL Detection for more details on the operation of the loss-of-lock circuit.

#### 4.4.5 Holdover Mode

The DSPLL will automatically enter holdover mode when the selected input clock becomes invalid and no other valid input clocks are available for selection. The DSPLL uses an averaged input clock frequency as its final holdover frequency to minimize the disturbance of the output clock phase and frequency when an input clock suddenly fails. The holdover circuit for the DSPLL stores up to 120 seconds of historical frequency data while locked to a valid clock input. The final averaged holdover frequency value is calculated from a programmable window within the stored historical frequency data. Both the window size and the delay are programmable as shown in the figure below. The window size determines the amount of holdover frequency averaging. The delay value allows ignoring frequency data that may be corrupt just before the input clock failure.

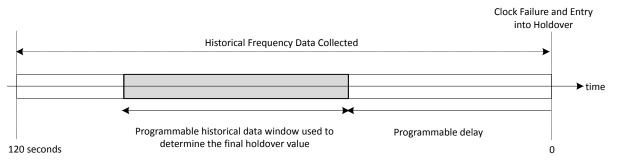


Figure 4.2. Programmable Holdover Window

When entering holdover, the DSPLL will pull its output clock frequency to the calculated averaged holdover frequency. While in holdover, the output frequency drift is entirely dependent on the external crystal or external reference clock connected to the XA/XB pins. If the clock input becomes valid, the DSPLL will automatically exit the holdover mode and re-acquire lock to the new input clock. This process involves pulling the output clock frequency to achieve frequency and phase lock with the input clock. This pull-in process is glitchless and its rate is controlled by the DSPLL or the Fastlock bandwidth.

The DSPLL output frequency when exiting holdover can be ramped (recommend). Just before the exit is initiated, the difference between the current holdover frequency and the new desired frequency is measured. Using the calculated difference and a user-select-able ramp rate, the output is linearly ramped to the new frequency. The ramp rate can be 0.2 ppm/s, 40,000 ppm/s, or any of about 40 values in between. The DSPLL loop BW does not limit or affect ramp rate selections (and vice versa). CBPro defaults to ramped exit from holdover. The same ramp rate settings are used for both exit from holdover and ramped input switching. For more information on ramped input switching, see 4.7.4 Frequency Ramped Input Switching.

**Note:** If ramped holdover exit is not selected, the holdover exit is governed either by (1) the DSPLL loop BW or (2) a user-selectable holdover exit BW.

#### 4.4.6 Frequency-on-the-Fly (FOTF)

The Si5395/94/92 use register writes to support frequency-on-the-fly to allow frequency changes on one MultiSynth without affecting the clocks generated from other MultiSynths. See the Si5395-94-92 Family Reference Manual and AN1178: Frequency-On-the-Fly for Skyworks Jitter Attenuators and Clock Generators for more details.

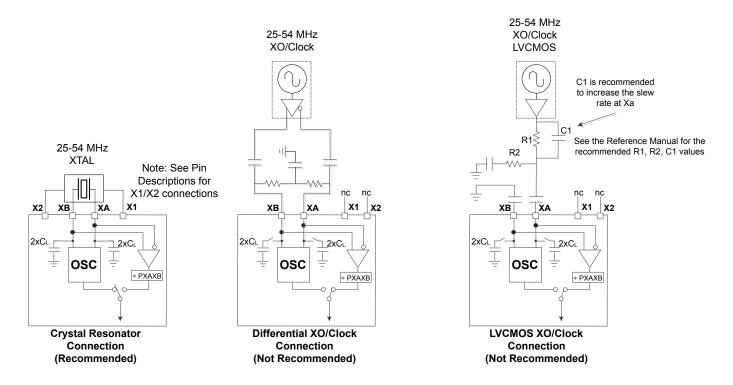
#### 4.5 Digitally Controlled Oscillator (DCO) Mode (Grade A/B/C/D and J/K/L/M)

The output MultiSynths support a DCO mode where their output frequencies are adjustable in predefined steps defined by frequency step words (FSW). The frequency adjustments are controlled through the serial interface or by pin control using frequency increment (FINC) or decrement (FDEC). A FINC will add the frequency step word to the DSPLL output frequency, while a FDEC will decrement it. Any number of MultiSynths can be updated at once or independently controlled. The DCO mode is available when the DSPLL is operating in either free-run or locked mode.

#### 4.6 External Reference (Grade A/B/C/D/P Only)

An external crystal (XTAL) or crystal oscillator (XO) is used in combination with the internal oscillator (OSC) to produce an ultra low jitter reference clock for the DSPLL and for providing a stable reference for the free-run and holdover modes. A simplified diagram is shown in the figure below. The device includes internal XTAL loading capacitors which eliminates the need for external capacitors and also has the benefit of reduced noise coupling from external sources. Refer to Table 5.12 External Crystal Specifications for Grades A/B/C/D/P on page 39 for crystal specifications. For the A/B/C/D grades, a crystal in the range of 48 MHz to 54 MHz is recommended for best jitter performance. The P grade devices must use a high quality 48 MHz crystal to achieve the ultra low jitter specification. The family reference manual provides additional information on PCB layout recommendations for the crystal to ensure optimum jitter performance.

To achieve optimal jitter performance and minimize BOM cost, a crystal is recommended on the XA/XB reference input. For SyncE pizza box applications (e.g. loop bandwidth set to 0.1 Hz), a TCXO is required on the XA/XB reference to minimize wander and to provide a stable holdover reference. See the Si5395-94-92 Family Reference Manual for more information. Selection between the external XTAL or REFCLK is controlled by register configuration. The internal crystal loading capacitors (CL) are disabled in the REFCLK mode. Refer to Table 5.3 Input Clock Specifications on page 26 for REFCLK requirements when using this mode. A PREF divider is available to accommodate external clock frequencies higher than 54 MHz. Frequencies in the range of 48 MHz to 54 MHz will achieve the best output jitter performance.



Note: XA and XB must not exceed the maximum input voltage listed in Table 5.3 Input Clock Specifications on page 24

#### Figure 4.3. Crystal Resonator and External Reference Clock Connection Options

Note that connecting an external reference to a device that already has an integrated reference (grades J/K/L/M/E) is not allowed. Doing so could lead to internal damage to the circuits.

#### 4.7 Inputs (IN0, IN1, IN2, IN3)

There are four inputs that can be used to synchronize to the DSPLL. The inputs accept three formats of input clock: Standard Differential/Single-Ended, Standard LVCMOS or Pulsed CMOS (See Family Reference Manual for more details). Input selection can be manual (pin or register controlled) or automatic with user definable priorities.

#### 4.7.1 Manual Input Selection (IN0, IN1, IN2, IN3)

Input clock selection can be made manually using the IN\_SEL[1:0] pins or through a register. A register bit determines input selection as pin selectable (default) or register selectable. If there is no clock signal on the selected input, the device will automatically enter free-run or holdover mode. When the zero delay mode is enabled, IN3 becomes the feedback input (FB\_IN) and is not available for selection as a clock input.

	1 [4.0]	Selected Input				
IN_SE	:L[1:0]	Zero Delay Mode Disabled Zero Delay Mode En				
0	0	INO	INO			
0	1	IN1	IN1			
1	0	IN2	IN2			
1	1	IN3	Reserved			

Table 4.1.	Manual Input Sele	ection Using IN	_SEL[1:0] Pins
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#### 4.7.2 Automatic Input Selection (IN0, IN1, IN2, IN3)

An automatic input selection state machine is available in addition to the manual switching option. In automatic mode, the selection criteria is based on input clock qualification, input priority, and the revertive option. Only input clocks that are valid can be selected by the automatic clock selection state machine. If there are no valid input clocks available the DSPLL will enter the holdover mode. With revertive switching enabled, the highest priority input with a valid input clock is always selected. If an input with a higher priority becomes valid then an automatic switchover to that input will be initiated. With non-revertive switching, the active input will always remain selected while it is valid. If it becomes invalid an automatic switchover to a valid input with the highest priority will be initiated.

#### 4.7.3 Hitless Input Switching

Hitless switching is a feature that prevents a phase offset from propagating to the output when switching between two clock inputs that have a fixed phase relationship. A hitless switch can only occur when the two input frequencies are frequency locked meaning that they have to be exactly at the same frequency, or at an integer frequency relationship to each other. When hitless switching is enabled, the DSPLL simply absorbs the phase difference between the two input clocks during a input switch. When disabled, the phase difference between the two input clocks during a input switch. When disabled, the phase difference between the two input clocks during a input switch. The hitless switching feature supports clock frequencies down to the minimum input frequency of 8 kHz; however, for optimum hitless switching performance, higher input frequencies are recommended.

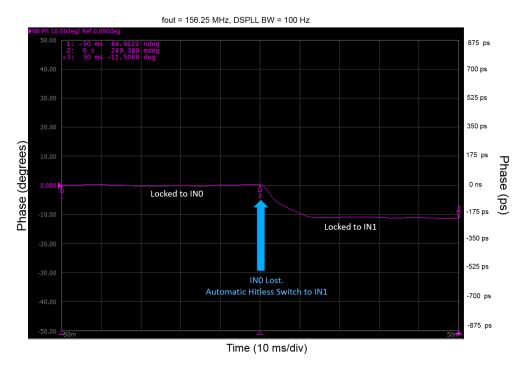
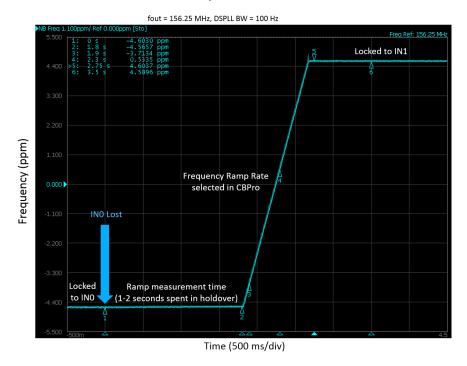


Figure 4.4. Output Phase Transient—Hitless Switching between Two 25 MHz Inputs (0 ppm, 180 Degree Phase Shift)

#### 4.7.4 Frequency Ramped Input Switching

The ramped input switching feature is enabled/disabled depending on both the frequency of the Phase-Frequency detector (Fpfd) and the difference in input frequencies (Zero-PPM vs non-zero PPM). The table below shows the selection criteria to enable ramped input switching. The same ramp rate settings are used for both holdover exit and clock switching. For more information on ramped exit from holdover, see 4.4.5 Holdover Mode and the Si5395-94-92 Family Reference Manual.



#### Figure 4.5. Output Frequency Transient-Ramped Switching between Two 8 kHz Inputs (±4.6 ppm Offset)

#### Table 4.2. Recommended Ramped Input Switching Settings for Internal Clock Switches

Maximum Input Frequency Difference	Fpfd <sup>1</sup> < 500 kHz	Fpfd <sup>1</sup> ≥ 500 kHz
0 ppm Frequency Locked	Ramped Exit from Holdover	
≤ 10 ppm	Ramped Input Switching and Ramped Exit from Holdover	Ramped Exit from Holdover
> 10 ppm	Ramped Input Switching and Ramped Exit f	rom Holdover
Note:		

1. The Fpfd value is determineby various requirements of the frequency plan and is displayed in the CBPro project file.

Always enable hitless switching and enable phase buildout on holdover exit. See the latest version of CBPro to properly configure the device.

#### 4.7.5 Glitchless Input Switching

The glitchless switching feature allows the DSPLL to switch between two input clock frequencies that are up to ±500 ppm apart without an abrupt phase change at the output. The DSPLL will pull-in to the new frequency using a ramped frequency step (if ramping is enabled) or using Fastlock/nominal lock parameters (if ramping is disabled).

The loss of lock (LOL) indicator will assert while the DSPLL is pulling-in to the new clock frequency.

#### 4.7.6 Synchronizing to Gapped Input Clocks (Grade A/B/C/D and J/K/L/M Only)

The DSPLL supports locking to an input clock that has missing periods. This is also referred to as a gapped clock. The purpose of gapped clocking is to modulate the frequency of a periodic clock by selectively removing some of its cycles. Gapping a clock severely increases its jitter so a phase-locked loop with high jitter tolerance and low loop bandwidth is required to produce a low-jitter periodic clock. The resulting output will be a periodic non-gapped clock with an average frequency of the input with its missing cycles. For example, an input clock of 100 MHz with one cycle removed every 10 cycles will result in a 90 MHz periodic non-gapped output clock. This is shown in the following figure. For more information on gapped clocks, see "AN561: Introduction to Gapped Clocks and PLLs".

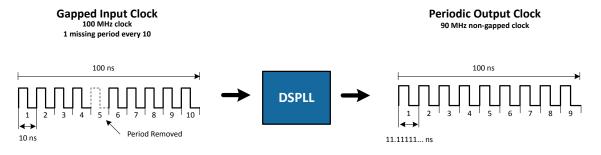


Figure 4.6. Generating an Averaged Clock Output Frequency from a Gapped Clock Input

A valid gapped clock input must have a minimum frequency of 10 MHz with a maximum of two missing cycles out of every eight. Locking to a gapped clock will not trigger the LOS, OOF, and LOL fault monitors. Clock switching between gapped clocks may violate the hitless switching specification in Table 5.8 Performance Characteristics on page 34 when the switch occurs during a gap in either input clock.

#### 4.8 Fault Monitoring

All four input clocks (IN0, IN1, IN2, IN3/FB\_IN) are monitored for loss of signal (LOS) and out-of-frequency (OOF) as shown in the figure below. The reference at the XA/XB pins is also monitored for LOS since it provides a critical reference clock for the DSPLL. There is also a Loss Of Lock (LOL) indicator, which is asserted when the DSPLL loses synchronization.

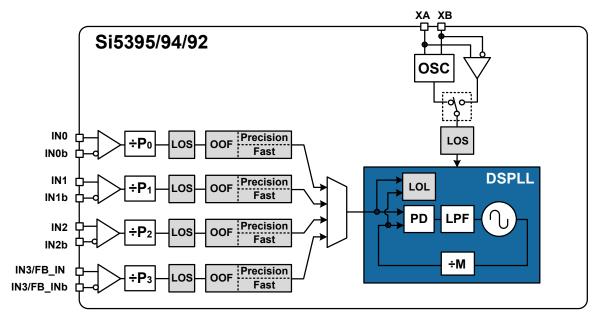


Figure 4.7. Si5395/94/92 Fault Monitors

#### 4.8.1 Input LOS Detection

The loss of signal monitor measures the period of each input clock cycle to detect phase irregularities or missing clock edges. Each of the input LOS circuits has its own programmable sensitivity which allows ignoring missing edges or intermittent errors. Loss of signal sensitivity is configurable using the ClockBuilder Pro utility. The LOS status for each of the monitors is accessible by reading a status register. The live LOS register always displays the current LOS state and a sticky register always stays asserted until cleared. An option to disable any of the LOS monitors is also available.

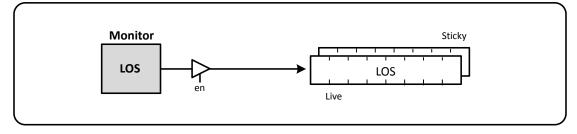


Figure 4.8. LOS Status Indicators

#### 4.8.2 XA/XB LOS Detection

A LOS monitor is available to ensure that the external crystal or reference clock is valid. By default the output clocks are disabled when XAXB\_LOS is detected. This feature can be disabled such that the device will continue to produce output clocks when XAXB\_LOS is detected.

#### 4.8.3 OOF Detection

Each input clock is monitored for frequency accuracy with respect to a OOF reference which it considers as its "0\_ppm" reference. This OOF reference can be selected as either:

- · XA/XB pins
- Any input clock (IN0, IN1, IN2, IN3)

The final OOF status is determined by the combination of both a precise OOF monitor and a fast OOF monitor as shown in the figure below. An option to disable either monitor is also available. The live OOF register always displays the current OOF state, and its sticky register bit stays asserted until cleared.

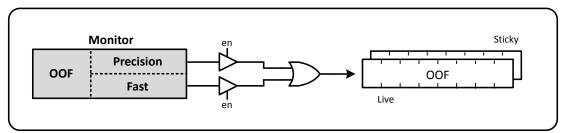


Figure 4.9. OOF Status Indicator

#### 4.8.3.1 Precision OOF Monitor

The precision OOF monitor circuit measures the frequency of all input clocks to within  $\pm 1/16$  ppm accuracy with respect to the selected OOF frequency reference. A valid input clock frequency is one that remains within the OOF frequency range which is register configurable up to  $\pm 512$  ppm in steps of 1/16 ppm. A configurable amount of hysteresis is also available to prevent the OOF status from toggling at the failure boundary. An example is shown in the figure below. In this case, the OOF monitor is configured with a valid frequency range of  $\pm 6$  ppm and with 2 ppm of hysteresis. An option to use one of the input pins (IN0–IN3) as the 0 ppm OOF reference instead of the XA/XB pins is available. This option is register configurable.

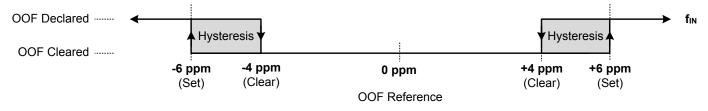


Figure 4.10. Example of Precise OOF Monitor Assertion and Deassertion Triggers

#### 4.8.3.2 Fast OOF Monitor

Because the precision OOF monitor needs to provide 1/16 ppm of frequency measurement accuracy, it must measure the monitored input clock frequencies over a relatively long period of time. This may be too slow to detect an input clock that is quickly ramping in frequency. An additional level of OOF monitoring called the Fast OOF monitor runs in parallel with the precision OOF monitors to quickly detect a ramping input frequency. The Fast OOF monitor asserts OOF on an input clock frequency that has changed by greater than ±4000 ppm.

#### 4.8.4 LOL Detection

The Loss Of Lock (LOL) monitor asserts a LOL register bit when the DSPLL has lost synchronization with its selected input clock. There is also a dedicated loss of lock pin that reflects the loss of lock condition. The LOL monitor functions by measuring the frequency difference between the input and feedback clocks at the phase detector. There are two LOL frequency monitors, one that sets the LOL indicator (LOL Set) and another that clears the indicator (LOL Clear). An optional timer is available to delay clearing of the LOL indicator to allow additional time for the DSPLL to completely lock to the input clock. The timer is also useful to prevent the LOL indicator from toggling or chattering as the DSPLL completes lock acquisition. A block diagram of the LOL monitor is shown in the figure below. The live LOL register always displays the current LOL state and a sticky register always stays asserted until cleared. The LOL pin reflects the current state of the LOL monitor.

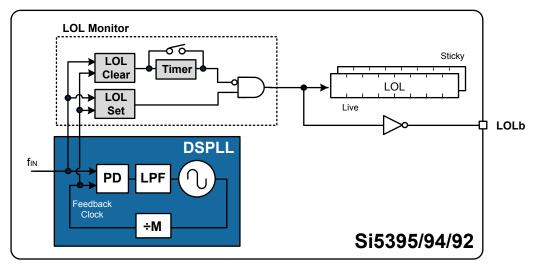
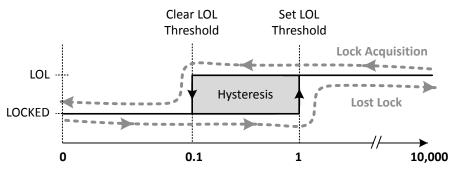


Figure 4.11. LOL Status Indicators

The LOL frequency monitors have an adjustable sensitivity which is register configurable from 0.1 ppm to 10,000 ppm. Having two separate frequency monitors allows for hysteresis to help prevent chattering of LOL status.

An example configuration where LOCK is indicated when there is less than 0.1 ppm frequency difference at the inputs of the phase detector and LOL is indicated when there's more than 1 ppm frequency difference is shown in the following figure.



Phase Detector Frequency Difference (ppm)

Figure 4.12. LOL Set and Clear Thresholds

An optional timer is available to delay clearing of the LOL indicator to allow additional time for the DSPLL to completely lock to the input clock. The timer is also useful to prevent the LOL indicator from toggling or chattering as the DSPLL completes lock acquisition. The configurable delay value depends on frequency configuration and loop bandwidth of the DSPLL and is automatically calculated using the ClockBuilder Pro utility.

#### 4.8.5 Interrupt Pin (INTRb)

An interrupt pin (INTRb) indicates a change in state of the status indicators (LOS, OOF, LOL, HOLD). Any of the status indicators are maskable to prevent assertion of the interrupt pin. The state of the INTRb pin is reset by clearing the status register that caused the interrupt.

#### 4.9 Outputs

Each driver has a configurable voltage swing and common mode voltage covering a wide variety of differential signal formats. In addition to supporting differential signals, any of the outputs can be configured as single-ended LVCMOS (3.3 V, 2.5 V, or 1.8 V) providing up to 20 single-ended outputs, or any combination of differential and single-ended outputs.

#### 4.9.1 Grade A/B/C/D and J/K/L/M

The Si539x "standard" grades A/B/C/D (external reference) and J/K/L/M (integrated reference) can generate any output frequency in any format with best-in-class jitter. These devices are available as a preprogrammed option or can be written to the device via I<sup>2</sup>C. The input/output frequency plan determines whether the output divider operates in integer or fractional mode. In the fractional mode, the device can generate any output frequency or any format from any input frequency with best-in-class jitter. Some frequency plans allow the user to use an integer mode that delivers even lower jitter. See the Si5395-94-92 Family Reference Manual for more details.

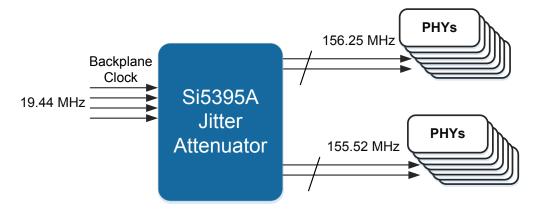


Figure 4.13. Si5395 A/B/C/D/J/K/L/M Jitter Attenuator

#### 4.9.2 Grades P and E

Some applications, like 56G PAM4 SerDes, require even higher performance (< 100fs MAX) than is already provided by standard Skyworks jitter attenuators (<140fs MAX). The Si539x grades P (external reference) and E (integrated reference) are Precision grade jitter attenuators that calibrate out linearity errors to deliver the world's best jitter performance over a wide range of frequency plans.

The Si5392P/E can support 1 clock domain while the Si5394P/E supports 1 or 2 clock domains and the Si5395P/E can support 1, 2 or 3 clock domains while delivering guaranteed low jitter of 100fs MAX on the primary SerDes clocks. The frequencies supported by the 3 domains are

- Domain#1 (Si5395/94/92 P/E) 156.25/312.5/625 MHz
- Domain#2 (Si5395/94 P/E) 25/50/100/125/200/156.25/312.5/625 MHz
- Domain#3 (Si5395 P/E) 25/50/100/125/200/156.25/312.5/625/322.265625/644.53125 MHz

The examples below show examples of how each of the 3 devices can be used as jitter attenuators in 56G Pam4 SerDes applications.

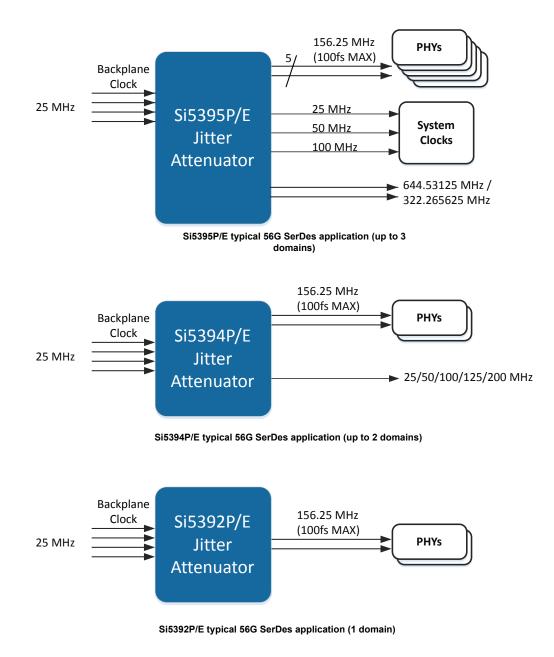


Figure 4.14. Typical Grade P and Grade E 56G SerDes Applications

The external reference used on the XA/XB pins of the P grade is restricted to a 48 MHz crystal. No other values of crystal or other reference sources like XO or VCXO are allowed. If the design requires other crystal frequencies, then the standard Si539xA/B/C/D should be used instead of the Si539xP.

To deliver guaranteed jitter performance 100fs MAX on the 56 G Pam4 SerDes clocks, the additional system clocks must follow some specific design rules. Additionally, the device input clocks should be traceable back to a Stratum 3 primary reference clock. See the Si5395/94/92 Family Reference manual for more details on these design rules.

#### 4.9.3 Output Crosspoint

A crosspoint allows any of the output drivers to connect with any of the MultiSynths. The crosspoint configuration is programmable and can be stored in NVM so that the desired output configuration is ready at power up.

#### 4.9.4 Output Signal Format

The differential output swing and common mode voltage are both fully programmable covering a wide variety of signal formats including LVDS and LVPECL. In addition to supporting differential signals, any of the outputs can be configured as LVCMOS (3.3 V, 2.5 V, or 1.8 V) drivers providing up to 20 single-ended outputs, or any combination of differential and single-ended outputs.

#### 4.9.5 Programmable Common Mode Voltage For Differential Outputs

The common mode voltage ( $V_{CM}$ ) for the differential modes are programmable so that LVDS specifications can be met and for the best signal integrity with different supply voltages. When DC coupling the output driver, it is essential that the receiver have a relatively high common mode impedance so that the common mode current from the output driver is very small.

#### 4.9.6 LVCMOS Output Impedance Selection

Each LVCMOS driver has a configurable output impedance to accommodate different trace impedances. A source termination resistor is recommended to help match the selected output impedance to the trace impedance, where Rs = Transmission line impedance –  $Z_0$ . There are three programmable output impedance selections (CMOS1, CMOS2, CMOS3) for each VDDO option as shown in the following table.

VDDO		CMOS Drive Selections	
	OUTx_CMOS_DRV = 1	OUTx_CMOS_DRV = 2	OUTx_CMOS_DRV = 3
3.3 V	38 Ω	30 Ω	22 Ω
2.5 V	43 Ω	35 Ω	24 Ω
1.8 V	—	46 Ω	31 Ω

#### Table 4.3. Typical Output Impedance (Z<sub>S</sub>)

#### 4.9.7 LVCMOS Output Signal Swing

The signal swing  $(V_{OL}/V_{OH})$  of the LVCMOS output drivers is set by the voltage on the VDDO pins. Each output driver has its own VDDO pin allowing a unique output voltage swing for each of the LVCMOS drivers.

#### 4.9.8 LVCMOS Output Polarity

When a driver is configured as an LVCMOS output, it generates a clock signal on both pins (OUTx and OUTxb). By default, the clock on the OUTx pin is generated with the same polarity (in phase) as the clock on the OUTxb pin. The polarity of these clocks is configurable, enabling complementary clock generation and/or inverted polarity with respect to other output drivers.

#### 4.9.9 Output Enable/Disable

The OEb pin provides a convenient method of disabling or enabling the output drivers. When the OEb pin is held high, all outputs are disabled. When held low, the outputs are enabled. Outputs in the enabled state can be individually disabled through register control.

#### 4.9.10 Output Driver State When Disabled

The disabled state of an output driver is configurable as disable low or disable high.

#### 4.9.11 Synchronous Output Disable Feature

The output drivers provide a selectable synchronous disable feature. Output drivers with this feature turned on will wait until a clock period has completed before the driver is disabled. This prevents unwanted runt pulses from occurring when disabling an output. When this feature is turned off, the output clock will disable immediately without waiting for the period to complete.

#### 4.9.12 Input/Output Skew Control

The input-output skew can be adjusted in dynamic mode. The dynamic phase adjust will allow the device to dynamically and glitchlessly change the output phase using register writes with the device still powered up. The skew value may change after each reset or power cycle. See the family reference manual for more details.

#### 4.9.13 Zero Delay Mode (Grades A/B/C/D and J/K/L/M)

A zero delay mode is available for applications that require fixed and consistent minimum delay between the selected input and outputs. The zero delay mode is configured by opening the internal feedback loop through software configuration and closing the loop externally as shown in the figure below. (Zero delay mode is only available for clock inputs that are higher than 128 kHz.)

This helps to cancel out the internal delay introduced by the dividers, the crosspoint, the input, and the output drivers. Any one of the outputs can be fed back to the FB\_IN pins, although using the output driver that achieves the shortest trace length will help to minimize the input-to-output delay. The OUT9 and FB\_IN pins are recommended for the external feedback connection. The FB\_IN input pins must be terminated and ac-coupled when zero delay mode is used. A differential external feedback path connection is necessary for best performance. Note that the hitless switching feature is not available when zero delay mode is enabled.

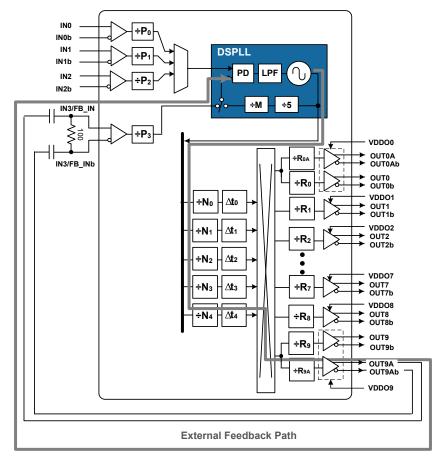


Figure 4.15. Si5395 Zero Delay Mode Setup

#### 4.9.14 Output Divider (R) Synchronization

All the output R dividers are reset to a known state during the power-up initialization period. This ensures consistent and repeatable phase alignment across all output drivers that are connected to the same N divider.

#### 4.10 Power Management

Unused inputs and output drivers can be powered down when unused. Consult the Si5395-94-92 Family Reference Manual and ClockBuilder Pro configuration utility for details.

#### 4.11 In-Circuit Programming

The Si5395/94/92 is fully configurable using the serial interface (I<sup>2</sup>C or SPI). At power-up the device downloads its default register values from internal non-volatile memory (NVM). Application specific default configurations can be written into NVM allowing the device to generate specific clock frequencies at power-up. Writing default values to NVM is in-circuit programmable with normal operating power supply voltages applied to its V<sub>DD</sub> and V<sub>DDA</sub> pins. The NVM is two time writable. Once a new configuration has been written to NVM, the old configuration is no longer accessible. Refer to the Si5395-94-92 Family Reference Manual for a detailed procedure for writing registers to NVM.

#### 4.12 Serial Interface

Configuration and operation of the Si5395/94/92 is controlled by reading and writing registers using the I<sup>2</sup>C or SPI interface. The I2C\_SEL pin selects I<sup>2</sup>C or SPI operation. Communication with both 3.3 V and 1.8 V host is supported. The SPI mode operates in either 4-wire or 3-wire. See the Si5395-94-92 Family Reference Manual for details.

#### 4.13 Custom Factory Preprogrammed Parts

For applications where a serial interface is not available for programming the device, custom pre-programmed parts can be ordered with a specific configuration written into NVM. A factory preprogrammed part will generate clocks at power-up. Custom, factory-preprogrammed devices are available. The ClockBuilder Pro custom part number wizard can be used to quickly and easily generate a custom part number for your configuration.

In less than three minutes, you will be able to generate a custom part number with a detailed data sheet addendum matching your design's configuration. Once you receive the confirmation email with the data sheet addendum, simply place an order with your local Skyworks sales representative. Samples of your preprogrammed device will typically ship in about two weeks.

#### 4.14 Register Map

The register map is divided into multiple pages where each page has 256 addressable registers. Page 0 contains frequently accessible registers, such as alarm status, resets, device identification, etc. Other pages contain registers that need less frequent access such as frequency configuration, and general device settings. Refer to the Si5395-94-92 Family Reference Manual for a complete list of register descriptions and settings. It is strongly recommended that ClockBuilder Pro be used to create and manage register settings.

#### 5. Electrical Specifications

#### Table 5.1. Recommended Operating Conditions<sup>1</sup>

Parameter	Symbol	Min	Тур	Мах	Unit
Ambient Temperature	T <sub>A</sub>	-40	25	85	°C
Junction Temperature	TJ <sub>MAX</sub>	_	_	125	°C
Core Supply Voltage	V <sub>DD</sub>	1.71	1.80	1.89	V
	V <sub>DDA</sub>	3.14	3.30	3.47	V
		3.14	3.30	3.47	V
Clock Output Driver Supply Voltage	V <sub>DDO</sub>	2.37	2.50	2.62	V
		1.71	1.80	1.89	V
Status Pin Supply Voltage	V <sub>DDS</sub>	3.14	3.30	3.47	V
Status Fin Supply voltage	v DDS	1.71	1.80	1.89	V

#### Note:

1. All minimum and maximum specifications are guaranteed and apply across the recommended operating conditions. Typical values apply at nominal supply voltages and an operating temperature of 25 °C unless otherwise noted.

#### Table 5.2. DC Characteristics

 $V_{DD} = 1.8 \text{ V} \pm 5\%, V_{DDA} = 3.3 \text{ V} \pm 5\%, V_{DDIO}/V_{DDS} = 3.3 \text{ V} \pm 5\%, 1.8 \text{ V} \pm 5\%, V_{DDO} = 1.8 \text{ V} \pm 5\%, 2.5 \text{ V} \pm 5\%, \text{ or } 3.3 \text{ V} \pm 5\%, T_{A} = -40 \text{ to } 85 \text{ °C}$ 

Parameter	Symbol	Test Condition	Min	Тур	Мах	Unit
	I	Si5395	_	150	300	mA
Core Currenty Current <sup>1</sup> 2 3	I <sub>DD</sub>	Si5394/92	_	125	250	mA
Core Supply Current <sup>1, 2, 3</sup>		Si5395	_	125	140	mA
	I <sub>DDA</sub>	Si5394/92	_	115	130	mA
		2.5 V LVPECL Output <sup>4</sup>		22	26	mA
	I <sub>DDOx</sub>	2.5 V LVDS Output <sup>4</sup>	_	15	18	mA
Output Buffer Supply Current		3.3 V LVCMOS Output <sup>5</sup>	_	22	30	mA
		2.5 V LVCMOS Output <sup>5</sup>		18	23	mA
		1.8 V LVCMOS Output <sup>5</sup>		12	16	mA
Total Power Dissipation <sup>6</sup>		Si5395 <sup>1</sup>		1000	1400	mW
	Pd	Si5394 <sup>2</sup>	_	750	1100	mW
		Si5392 <sup>3</sup>	_	680	1000	mW

#### Notes:

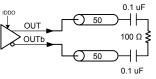
1. Si5395 test configuration: 7 x 2.5 V LVDS outputs enabled at 156.25 MHz. Excludes power in termination resistors.

2. Si5394 test configuration: 4 x 2.5 V LVDS outputs enabled at 156.25 MHz. Excludes power in termination resistors.

3. Si5392 test configuration: 2 x 2.5 V LVDS outputs enabled at 156.25 MHz. Excludes power in termination resistors.

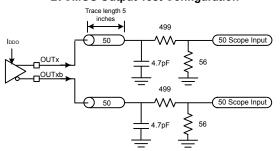
4. Differential outputs enabled at 156.25 MHz and terminated into an ac-coupled 100  $\Omega$  load.

#### **Differential Output Test Configuration**



5. LVCMOS outputs enabled at 156.25 MHz and measured into a 5 inch 50 Ω PCB trace with 4.7 pF load. Measurements were made with OUTx\_CMOS\_DRV=3. See Reference Manual for more details on register settings.

LVCMOS Output Test Configuration



6. Detailed power consumption for any configuration can be estimated using ClockBuilder Pro when an evaluation board (EVB) is not available. All EVBs support detailed current measurements for any configuration.

#### Table 5.3. Input Clock Specifications

#### $V_{DD}$ = 1.8 V ±5%, $V_{DDA}$ = 3.3 V ±5%, $T_A$ = –40 to 85 $^\circ C$

Parameter	Symbol	Test Condition	Min	Тур	Мах	Unit
Standard Differential or Single-E	Ended - AC Couple	d Input Buffer (IN0/IN0b, IN1/IN1b	, IN2/IN2	o, IN3/FB_	IN, IN3b/FE	B_INb)
		Differential	0.008	_	750	MHz
Input Frequency Range	f <sub>IN</sub>	All Single-ended signals	0.008		250	MHz
		(including LVCMOS)	0.008	_	250	
		Differential AC-coupled	100		1800	m\/nn .co
		f <sub>IN</sub> < 250 MHz	100		1800	mVpp_se
Voltage Swing <sup>1</sup>	V <sub>IN</sub>	Differential AC-coupled	225	_	1800	mVpp_se
		250 MHz < f <sub>IN</sub> < 750 MHz				
		Single-ended AC-coupled f <sub>IN</sub> < 250 MHz	100	_	3600	mVpp_se
Slew Rate <sup>2, 3</sup>	SR		400			V/µs
Duty Cycle	DC		40		60	%
Input Capacitance	C <sub>IN</sub>			2.4		pF
Input Resistance Differential	R <sub>IN_DIFF</sub>			16		kΩ
Input Resistance Single-Ended	R <sub>IN_SE</sub>			8		kΩ
LVCMOS / Pulsed CMOS DC-Co	upled Input Buffer	(IN0, IN1, IN2, IN3/FB_IN) <sup>4</sup>				
Input Frequency	f <sub>IN_CMOS</sub>	Standard CMOS & Non-standard CMOS	0.008	_	250	MHz
		Pulsed CMOS	0.008		1	MHz
		Standard CMOS	_	_	0.5	V
	V <sub>IL</sub>	Non-standard CMOS & Pulsed CMOS			0.4	V
Input Voltage <sup>5</sup>		Standard CMOS	1.3			V
	V <sub>IH</sub>	Non-standard CMOS & Pulsed CMOS	0.8		_	V
Slew Rate <sup>2, 3</sup>	SR		400			V/µs
Duty Cycle	DC	Standard CMOS & Non-standard CMOS	40		60	%
		Pulsed CMOS	5		95	
		Standard CMOS &				
		Non-standard CMOS	1.6	_	-	
Minimum Pulse Width	PW	(250 MHz @ 40% Duty Cycle)				ns
		Pulsed CMOS (1 MHz @ 40% Duty Cycle)	50	50 — —		
Input Resistance	R <sub>IN</sub>		_	8	_	kΩ

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
REFCLK (Applied to XA/XB) (G	irade A/B/C/D)					
		Full operating range. Jitter per- formance may be reduced.	24.97	_	54.06	MHz
REFCLK Frequency	f <sub>IN_REF</sub>	Range for best jitter.	48		54	MHz
REFCLK Frequency	'IN_KEF	TCXO frequency for SyncE applications. Jitter perform- ance may be reduced.	_	40	_	MHz
Input Single-ended Voltage Swing	V <sub>IN_SE</sub>		365	_	2000	mVpp_se
Input Differential Voltage Swing	V <sub>IN_DIFF</sub>		365		2500	mVpp_diff
Slew Rate <sup>2, 3</sup>	SR		400			V/µs
Duty Cycle	DC		40	_	60	%

#### Note:

1. Voltage swing is specified as single-ended mVpp.

	Vcm Vpp_se		Vpp_diff = 2*Vpp_se
--	------------	--	---------------------

2. Recommended for specified jitter performance. Slew rate can go lower, but jitter performance could degrade if the minimum slew rate specification is not met (see the Si5395-94-92 Family Reference Manual).

- 3. Rise and fall times can be estimated using the following simplified equation: tr/tf<sub>80-20</sub> = ((0.8 0.2) x V<sub>IN Vpp se</sub>) / SR.
- 4. Standard, Non-standard and Pulsed CMOS refer to different formats of CMOS each with a voltage swing of 1.8V, 2.5V or 3.3V +/-5%.
  - · Standard CMOS refers to the industry standard LVCMOS signal.
  - Non-standard CMOS refers to a signal that has been attenuated/level-shifted in order to comply with the specified non-standard VIL and VIH specifications.
  - Pulsed CMOS refers to a signal that has been attenuated/level-shifted and has a low/high duty cycle and must be dc coupled. A typical application example is a low-frequency video frame sync pulse.

Refer to the Si5395-94-92 Family Reference Manual for the recommended connections/termination for the different modes.

5. CMOS signals that exceed 3.3 V + 5% can be used as inputs as long as a resistive attenuation network is used to guarantee that the input voltage at the pin does not violate the device's input ratings. Please refer to the Si5395-94-92 Family Reference Manual for the recommended connections/termination for this mode.

#### Table 5.4. Serial and Control Input Pin Specifications

#### $V_{DD}$ = 1.8 V ±5%, $V_{DDA}$ = 3.3 V ±5%, $V_{DDIO}/V_{DDS}$ = 3.3 V ±5%, 1.8 V ±5%, $T_A$ = -40 to 85 °C

Parameter	Symbol	Test Condition	Min	Тур	Мах	Unit
Si5395 Serial and Control In	put Pins (I2C_SEL,	IN_SEL[1:0], RSTb, OEb, A	A1/SDO, SCLI	K, A0/CSb, F	NC, FDEC, SD	A/SDIO)
Input Voltage	VIL		_	_	0.3 × V <sub>DDIO</sub> 1	V
	V <sub>IH</sub>		0.7 × V <sub>DDIO</sub> 1	_	_	V
Input Capacitance	C <sub>IN</sub>		—	2	_	pF
Input Resistance	R <sub>IN</sub>		_	20	_	kΩ
Minimum Pulse Width	PW	RSTb, FINC and FDEC	100	_	_	ns
Update Rate	T <sub>UR</sub>	FINC and FDEC	1		_	μs
Si5394/92 Serial and Control	I Input Pins (I2C_S	EL, IN_SEL[1:0], RSTb, OE	b, A1/SDO, S	CLK, A0/CSb	, SDA/SDIO)	
Input Voltage	V <sub>IL</sub>		_	_	0.3 × V <sub>DDIO</sub> 1	V
Input Voltage	V <sub>IH</sub>		0.7 × V <sub>DDIO</sub> 1	_	_	V
Input Capacitance	C <sub>IN</sub>		_	2	_	pF
Input Resistance	R <sub>IN</sub>			20	_	kΩ
Minimum Pulse Width	PW	RSTb	100	_	_	ns

1. V<sub>DDIO</sub> is determined by the IO\_VDD\_SEL bit. It is selectable as V<sub>DDA</sub> or V<sub>DD</sub>. See the Si5395-94-92 Family Reference Manual for more details on the proper register settings.

#### Table 5.5. Differential Clock Output Specifications

#### $V_{DD}$ = 1.8 V ±5%, $V_{DDA}$ = 3.3 V ±5%, $V_{DDO}$ = 1.8 V ±5%, 2.5 V ±5%, or 3.3 V ±5%, $T_A$ = -40 to 85 °C

Parameter	Symbol	Test Con	dition	Min	Тур	Max	Unit
Si5395/94/92							1
				0.0001		720	MHz
	,	MultiSynth not used		733.33	_	800.00	MHz
Output Frequency	fout			825		1028	MHz
		MultiSynt	h used	0.0001		720	MHz
		MultiSyntl	h used:				
		f <sub>OUT</sub> < 40	0 MHz	48		52	%
		MultiSyntl	h used:				
Duty Cycle <sup>1</sup>	DC	400 MHz < f <sub>C</sub> MH	<sub>DUT</sub> <= 720	45	_	55	%
		MultiSynth	not used:	25		75	%
		f <sub>OUT</sub> < 102	28 MHz				
Output Voltage Swing <sup>2</sup>	VOUT	V <sub>DDO</sub> = 3.3 V, 2.5 V, 1.8 V	LVDS	350	450	530	mVpp_se
Output voitage Swing-	VOUT	V <sub>DDO</sub> = 3.3 V, 2.5 V	LVPECL	630	780	950	mVpp_se
	VCM	V <sub>DDO</sub> = 3.3 V	LVDS	1.1	1.2	1.3	V
			LVPECL	1.9	2.0	2.1	V
Common Mode Voltage <sup>2, 3</sup> (100 $\Omega$ load line-to-line)		V <sub>DDO</sub> = 2.5 V	LVPECL LVDS	1.1	1.2	1.3	v
		V <sub>DDO</sub> = 1.8 V	sub-LVDS	0.8	0.9	1.0	V
Output-to-Output Skew (Same MultiSynth)	T <sub>SKS</sub>	f <sub>OUT</sub> = 712 (LVD		_	0	75	ps
Out-Outb Skew on one output	TSK_OUT	Measured from negative output		_	0	50	ps
Rise and Fall Times <sup>2</sup>	t <sub>r</sub> /t <sub>f</sub>	f <sub>OUT</sub> > 100 M 80%		_	100	200	ps
Differential Output Impedance	ZO			_	100	_	Ω
		10 kHz sinus	oidal noise	_	-101	—	dBc
Power Supply Noise Rejec-		100 kHz sinus	soidal noise	_	-96	—	dBc
tion <sup>3</sup>	PSRR	500 kHz sinus	soidal noise	_	-99	_	dBc
		1 MHz sinus	oidal noise	_	-97	_	dBc
		Si53	95	_	-72	_	dBc
Output-to-Output Crosstalk <sup>4</sup>	XTALK	Si5394	1/92	_	-88	_	dBc

Parameter	Symbol	Test Condition	Min	Тур	Мах	Unit
otes:						
1. Duty cycle can vary depend	ina on frequency	plan (output frequency and d	livide ratios).			
2. Output amplitude and comm				ngs and can be	e stored in NV	M.
Each output driver can be p	rogrammed inde	pendently. Note that the maxing	mum LVDS s	ingle-ended a	nplitude can b	e
		naximum. Refer to the Si5395- ons of voltage amplitude and o				
				ie voltages se	ango are poss	
	↓ Vpp_se	Vpp_diff = 2*Vp	p_se			
OUTxb Vcm ↓	Ţ_ Vpp_se					
		) Differential Output Test Co	onfiguration			
			ingulation			
			1 uF 			
3. Measured for 156.25 MHz o measured.	arrier frequency.	100 mVpp sinewave noise ad	dded to VDD	O = 3.3 V and	noise spur am	plitude
	mizing Si534x Ji	in LVDS mode, with the victir tter Performance in Next Gen utputs must be terminated whe	eration Intern	et Infrastructu		

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#### Table 5.6. LVCMOS Clock Output Specifications

#### $V_{DD}$ = 1.8 V ±5%, $V_{DDA}$ = 3.3 V ±5%, $V_{DDO}$ = 1.8 V ±5%, 2.5 V ±5%, or 3.3 V ±5%, T<sub>A</sub> = -40 to 85 °C

Parameter	Symbol	Test Conditi	ion	Min	Тур	Max	Unit		
Output Frequency	fout			0.0001	_	250	MHz		
Dute Quele	<b>D</b> 0	f <sub>OUT</sub> <100 MHz		48	_	52	%		
Duty Cycle	DC	100 MHz < f <sub>OUT</sub> <	250 MHz	44	_	56	%		
		V <sub>DDO</sub> = 3.3 V							
		OUTx_CMOS_DRV = 1	I <sub>OH</sub> = –10 mA	V <sub>DDO</sub> x 0.85	_	_	V		
		OUTx_CMOS_DRV = 2	I <sub>OH</sub> = –12 mA	V <sub>DDO</sub> x 0.85	_	_	V		
		OUTx_CMOS_DRV = 3	I <sub>OH</sub> = –17 mA	V <sub>DDO</sub> x 0.85	_	_	V		
			V	<sub>DDO</sub> = 2.5 V					
Output Voltage High <sup>1, 2, 3</sup>	V <sub>OH</sub>	OUTx_CMOS_DRV = 1	I <sub>OH</sub> = –6 mA	V <sub>DDO</sub> x 0.85	_	_	V		
		OUTx_CMOS_DRV = 2	I <sub>OH</sub> = –8 mA	V <sub>DDO</sub> x 0.85	_	_	V		
		OUTx_CMOS_DRV = 3	I <sub>OH</sub> = –11 mA	V <sub>DDO</sub> x 0.85	_	_	V		
		V <sub>DDO</sub> = 1.8 V							
		OUTx_CMOS_DRV = 2	I <sub>OH</sub> = –4 mA	V <sub>DDO</sub> x 0.85	_	_	V		
		OUTx_CMOS_DRV = 3	I <sub>OH</sub> = –5 mA	V <sub>DDO</sub> x 0.85		_	V		
		V <sub>DDO</sub> = 3.3 V							
		OUTx_CMOS_DRV = 1	I <sub>OL</sub> = 10 mA	_	_	V <sub>DDO</sub> x 0.15	V		
		OUTx_CMOS_DRV = 2	I <sub>OL</sub> = 12 mA	_		V <sub>DDO</sub> x 0.15	V		
		OUTx_CMOS_DRV = 3	I <sub>OL</sub> = 17 mA	_	_	V <sub>DDO</sub> x 0.15	V		
			V	<sub>DDO</sub> = 2.5 V					
Output Voltage Low <sup>1, 2, 3</sup>	V <sub>OL</sub>	OUTx_CMOS_DRV = 1	I <sub>OL</sub> = 6 mA	_		V <sub>DDO</sub> x 0.15	V		
		OUTx_CMOS_DRV = 2	I <sub>OL</sub> = 8 mA	_	_	V <sub>DDO</sub> x 0.15	V		
		OUTx_CMOS_DRV = 3	I <sub>OL</sub> = 11 mA	_		V <sub>DDO</sub> x 0.15	V		
			V	<sub>DDO</sub> = 1.8 V					
		OUTx_CMOS_DRV = 2	I <sub>OL</sub> = 4 mA	_	_	V <sub>DDO</sub> x 0.15	V		
		OUTx_CMOS_DRV = 3	I <sub>OL</sub> = 5 mA	_	_	V <sub>DDO</sub> x 0.15	V		
			V <sub>DDO</sub> = 3.3V	_	400	600	ps		
Rise and Fall Times <sup>3</sup>	t <sub>r</sub> /t <sub>f</sub>	(20% to 80%)	V <sub>DDO</sub> = 2.5 V	_	450	600	ps		
			V <sub>DDO</sub> = 1.8 V	_	550	750	ps		

Parameter Symbol **Test Condition** Min Тур Max Unit Note: 1. Driver strength is a register programmable setting and stored in NVM. Options are OUTx\_CMOS\_DRV = 1, 2, 3. Refer to the Si5395-94-92 Family Reference Manual for more details on register settings. 2.  $I_{OL}/I_{OH}$  is measured at  $V_{OL}/V_{OH}$  as shown in the DC test configuration. **DC Test Configuration** Іог/Іон Inno Vol/Voh 3. A series termination resistor (Rs) is recommended to help match the source impedance to a 50 Ω PCB trace. A 4.7 pF capacitive load is assumed. The LVCMOS outputs were set to OUTx\_CMOS\_DRV = 3, at 156.25 MHz. **LVCMOS Output Test Configuration** Trace length 5 inches 499 50 50 Scope Input OUTx 56 OUTxb 499 50 Scope Input 50 56

#### Table 5.7. Output Status Pin Specifications

#### $V_{DD}$ = 1.8 V ±5%, $V_{DDA}$ = 3.3 V ±5%, $V_{DDIO}/V_{DDS}$ = 3.3 V ±5%, 1.8 V ±5%, $T_A$ = -40 to 85 °C

Parameter	Symbol	Test Condition	Min	Тур	Мах	Unit
Si5395 Status Output Pins	(LOLb, INTRb, SDA/S	SDIO <sup>1</sup> , SDO)				
0.45.41/645.55	V <sub>OH</sub>	I <sub>OH</sub> = -2 mA	V <sub>DDIO</sub> <sup>2</sup> x 0.85	_	_	V
Output Voltage	V <sub>OL</sub>	I <sub>OL</sub> = 2 mA	_	_	V <sub>DDIO</sub> <sup>2</sup> x 0.15	V
Si5394/92 Status Output Pi	ins (INTRb, SDA/SDIC	D1 <sup>1</sup> , SDO)				
	V <sub>OH</sub>	I <sub>OH</sub> = -2 mA	V <sub>DDIO</sub> <sup>2</sup> x 0.85	_	_	V
Output Voltage	V <sub>OL</sub>	I <sub>OL</sub> = 2 mA	_	_	V <sub>DDIO</sub> <sup>2</sup> x 0.15	V
Si5394 Status Output Pins	(LOLb, LOS_XAXBb)	)	I			
Si5392 Status Output Pins	(LOLb, LOS_XAXBb,	, LOS0b, LOS1b, LOS2b	, LOS3b)			
0.10.1010	V <sub>OH</sub>	I <sub>OH</sub> = –2 mA	V <sub>DDS</sub> x 0.85		_	V
Output Voltage	V <sub>OL</sub>	I <sub>OL</sub> = 2 mA	_	_	V <sub>DDS</sub> x 0.15	V
Notes:			I			
1. The V <sub>OH</sub> specification d with I2C_SEL pulled hig		-	out when the serial	interface is	s in I <sup>2</sup> C mode or is	unused
2. V <sub>DDIO</sub> is determined by	the IO_VDD_SEL bit.	It is selectable as V <sub>DDA</sub> o	r V <sub>DD</sub> . See the Si	5395-94-92	Family Reference	e Manual

 V<sub>DDIO</sub> is determined by the IO\_VDD\_SEL bit. It is selectable as V<sub>DDA</sub> or V<sub>DD</sub>. See the SI more details on the proper register settings.

#### Table 5.8. Performance Characteristics

#### $V_{DD}$ = 1.8 V ±5%, $V_{DDA}$ = 3.3 V ±5%, $V_{DDO}$ = 1.8 V ±5%, 2.5 V ±5%, or 3.3 V ±5%, T<sub>A</sub> = -40 to 85 °C

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
PLL Loop Bandwidth Pro- gramming Range <sup>1</sup>	f <sub>BW</sub>			0.1	-	4000	Hz
Initial Start-Up Time	t <sub>START</sub>	Time from power-up to when the device generates	Grade A/B/C/D/J/K/L/M	_	30	45	ms
		free-running clocks	Grade P/E	—	460	625	ms
PLL Lock Time <sup>2</sup>	t <sub>ACQ</sub>	With Fastlock enabled, f <sub>IN</sub> = 19.44 MHz		—	280	300	ms
Output Dynamic Delay Ad- justment	t <sub>DELAY</sub>	f <sub>VCO</sub> = 14 GHz		_	71.4	_	ps
	t <sub>RANGE</sub>				±1	_	ms
POR to Serial Interface Ready <sup>3</sup>	t <sub>RDY</sub>			_	_	15	ms
Maximum Phase Transient During a Hitless Switch <sup>4</sup>	tswitch	Single automatic/manual switch between two 8 kHz inputs, DSPLL BW = 40 Hz		_	_	1.5	ns
		Single automatic/manual switch between two 2 MHz inputs, DSPLL BW = 400 Hz		_	_	0.3	ns
Zero Delay Mode Input-to-Output Delay Varia- tion <sup>5</sup>	t <sub>ZDELAY</sub>	Between reference and feedback input with both clocks in LVDS differential format at 128 kHz.		_	_	0.20	ns
Jitter Peaking	J <sub>PK</sub>	Measured with a frequency plan running a 25 MHz input, 25 MHz output, and a Loop Band- width of 4 Hz		_	_	0.1	dB
Jitter Tolerance	J <sub>TOL</sub>	Compliant with G.8262 Options 1 and 2 for 1G, 10G or 25G Synchronous Ethernet Jitter Modulation Frequency = 10 Hz		_	3180	_	UI pk-pk
Pull-in Range	ω <sub>P</sub>			_	500	_	ppm
RMS Phase Jitter (Grade P) <sup>6</sup>	J <sub>GEN</sub>	f <sub>in</sub> = f <sub>out</sub> = 312.5 MHz or 156.25 MHz			75	100	fs
		f <sub>in</sub> = 25 MHz	f <sub>out</sub> = 156.25 MHz	_	69	90	fs
			f <sub>out</sub> = 312.5 MHz	_	69	95	fs
			f <sub>out</sub> = 100 MHz	_	150	200	fs
			f <sub>out</sub> = 50/25 MHz	_	200	300	fs
			f <sub>out</sub> = 644.531248 MHz	_	80	_	fs
RMS Phase Jitter (Grade E) <sup>6</sup>	J <sub>GEN</sub>	f <sub>in</sub> = f <sub>out</sub> = 312.5 MHz or 156.25 MHz		_	82	110	fs
		f <sub>in</sub> = 25 MHz	f <sub>out</sub> = 156.25 MHz	_	71	100	fs
			f <sub>out</sub> = 312.5 MHz	_	75	105	fs
			f <sub>out</sub> = 100 MHz	_	150	200	fs
			f <sub>out</sub> = 50/25 MHz	_	200	300	fs
			f <sub>out</sub> = 644.531248 MHz	_	85	_	fs

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Parameter	Symbol	Test Condition		Тур	Мах	Unit
RMS Phase Jitter		Output divider Integer Mode	_	85	120	fs
(Grade A/B/C/D and J/K/L/M) <sup>7</sup>	Grade A/B/C/D and J <sub>GEN</sub> (K/L/M) <sup>7</sup>	Output divider Fractional Mode/DCO Mode	_	115	170	fs

Note:

1. Actual loop bandwidth might be lower; please refer to CBPro for actual value for your frequency plan.

2. Lock Time can vary significantly depending on several parameters, such as bandwidths, LOL thresholds, etc. For this case, lock time was measured with nominal bandwidth set to 100 Hz, fastlock bandwidth set to 1 kHz, LOL set/clear thresholds of 6/0.6 ppm respectively, using IN0 as clock reference by removing the reference and enabling it again, then measuring the delta time between the first rising edge of the clock reference and the LOL indicator deassertion.

- 3. Measured as time from valid VDD/VDDA rails (90% of their value) to when the serial interface is ready to respond to commands.
- 4. Higher input frequencies will typically result in higher Fpfd frequencies, which, in turn, will result in better hitless switching performance. It is recommended to use higher input frequencies for the best hitless switching performance.
- 5. Zero-Delay-Mode is dependent on frequency configuration. Using Fpfd < 128 kHz will result in higher delay values. Ref clock rise time must be <200 ps. Initial Start-Up time can be much higher in Zero Delay mode.
- 6. Grade P and E are calibrated for optimum performance in 56G/112G SerDes applications at frequencies of 312.5 MHz or 156.25 MHz. Specific layout rules must be followed to achieve optimum performance. For more details, refer to 4.9.2 Grades P and E and the reference manual.
- 7. Grades A/B/C/D and J/K/L/M are targeted for applications that require more flexibility and set the output divider to Integer or Fractional modes. Integer mode test conditions: f<sub>in</sub> = 19.44 MHz; f<sub>out</sub> = 155.52 MHz. Fractional mode test conditions: f<sub>in</sub> = 19.44 MHz; f<sub>out</sub> = 125 MHz. All outputs are assumed to be LVPECL. For more details, refer to 4.9.1 Grade A/B/C/D and J/K/L/M.

## Table 5.9. I<sup>2</sup>C Timing Specifications (SCL, SDA)

Parameter	Symbol	I Test Condition	Standard Mode 100 kbps		Fast Mode 400 kbps		Unit
			Min	Max	Min	Max	
SCL Clock Frequency	f <sub>SCL</sub>		_	100	_	400	kHz
SMBus Timeout	_		25	35	25	35	ms
Hold time (Repeated) START condition	t <sub>HD:STA</sub>		4.0	_	0.6	_	μs
Low Period of the SCL Clock	t <sub>LOW</sub>		4.7	_	1.3	_	μs
HIGH Period of the SCL Clock	tніgн		4.0	_	0.6		μs
Setup Time for a Repeated START Condition	t <sub>SU:STA</sub>		4.7	_	0.6		μs
Data Hold Time	t <sub>HD:DAT</sub>		100	_	100	_	ns
Data Setup Time	t <sub>SU:DAT</sub>		250	_	100		ns
Rise Time of both SDA and SCL Signals	t <sub>r</sub>		_	1000	20	300	ns
Fall Time of both SDA and SCL Signals	t <sub>f</sub>		_	300	_	300	ns
Setup Time for STOP Condi- tion	<sup>t</sup> su:sто		4.0	_	0.6	_	μs
Bus Free Time between a STOP and START Condition	t <sub>BUF</sub>		4.7	_	1.3	_	μs
Data Valid Time	t <sub>VD:DAT</sub>		_	3.45	_	0.9	μs

 $V_{DD}$ = 1.8 V ±5%,  $V_{DDA}$ = 3.3 V ±5%,  $V_{DDS}/V_{DDIO}$ = 3.3 V ±5%, 1.8 V ±5%, T<sub>A</sub>= -40 to 85 °C

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Parameter	Parameter Symbol	Test Condition	Standard Mode 100 kbps		Fast Mode 400 kbps		Unit
			Min	Max	Min	Max	
Data Valid Acknowledge Time	t <sub>VD:ACK</sub>		_	3.45	_	0.9	μs

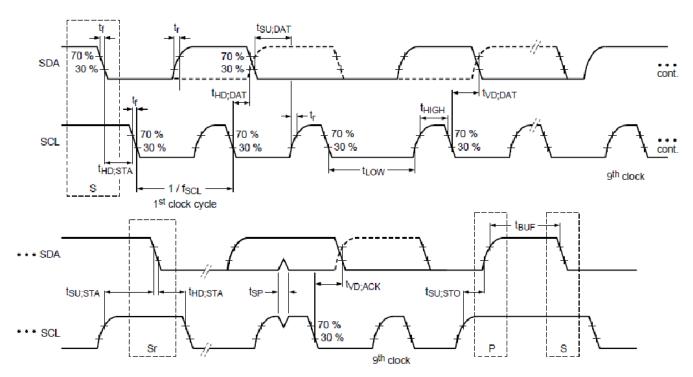


Figure 5.1. I<sup>2</sup>C Serial Port Timing Standard and Fast Modes

### Table 5.10. SPI Timing Specifications (4-Wire)

 $V_{DD}$  = 1.8 V ±5%,  $V_{DDA}$  = 3.3V ±5%,  $V_{DDIO}$ = 3.3 V ±5%, 1.8 V ±5%, T<sub>A</sub> = -40 to 85 °C

Parameter	Symbol	Min	Тур	Мах	Unit
SCLK Frequency	f <sub>SPI</sub>	_	_	20	MHz
SCLK Duty Cycle	T <sub>DC</sub>	40	_	60	%
SCLK Period	T <sub>C</sub>	50	_	_	ns
Delay Time, SCLK Fall to SDO Active	T <sub>D1</sub>	_	12.5	18	ns
Delay Time, SCLK Fall to SDO	T <sub>D2</sub>	_	10	15	ns
Delay Time, CSb Rise to SDO Tri-State	T <sub>D3</sub>	_	10	15	ns
Setup Time, CSb to SCLK	T <sub>SU1</sub>	5	_	_	ns
Hold Time, SCLK Fall to CSb	T <sub>H1</sub>	5	_	_	ns
Setup Time, SDI to SCLK Rise	T <sub>SU2</sub>	5	_	_	ns
Hold Time, SDI to SCLK Rise	T <sub>H2</sub>	5	_	_	ns
Delay Time Between Chip Selects (CSb)	T <sub>CS</sub>	95	_	_	ns

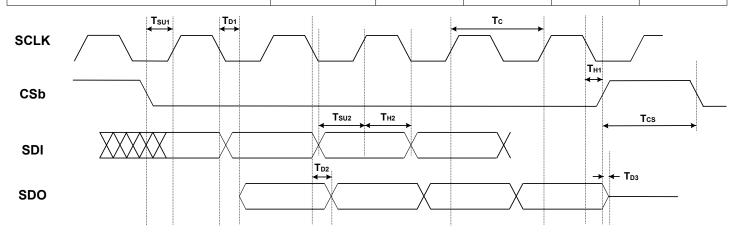


Figure 5.2. 4-Wire SPI Serial Interface Timing

### Table 5.11. SPI Timing Specifications (3-Wire)

 $V_{DD}$  = 1.8 V ±5%,  $V_{DDA}$  = 3.3V ±5%,  $V_{DDIO}$ = 3.3 V ±5%, 1.8 V ±5%, T<sub>A</sub> = -40 to 85 °C

Parameter	Symbol	Min	Тур	Мах	Unit
SCLK Frequency	f <sub>SPI</sub>	_	_	20	MHz
SCLK Duty Cycle	T <sub>DC</sub>	40	_	60	%
SCLK Period	T <sub>C</sub>	50	_	_	ns
Delay Time, SCLK Fall to SDIO Turn-on	T <sub>D1</sub>	_	12.5	18	ns
Delay Time, SCLK Fall to SDIO Next-bit	T <sub>D2</sub>	_	10	15	ns
Delay Time, CSb Rise to SDIO Tri-State	T <sub>D3</sub>	_	10	15	ns
Setup Time, CSb to SCLK	T <sub>SU1</sub>	5	_	_	ns
Hold Time, CSb to SCLK Fall	T <sub>H1</sub>	5	_	_	ns
Setup Time, SDI to SCLK Rise	T <sub>SU2</sub>	5	_	_	ns
Hold Time, SDI to SCLK Rise	T <sub>H2</sub>	5	_	_	ns
Delay Time Between Chip Selects (CSb)	T <sub>CS</sub>	95	_	_	ns

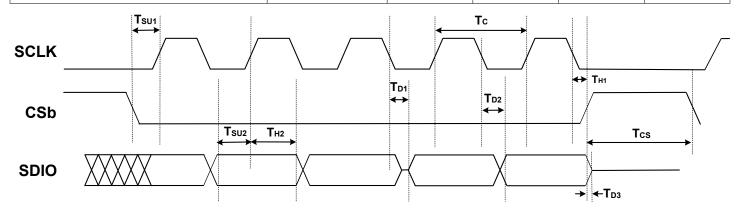


Figure 5.3. 3-Wire SPI Serial Interface Timing

Table 5.12.	External Crystal Specifications for Grades A/B/C/D/P
-------------	--

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Crystal Frequency Range	f <sub>XTAL</sub> (A/B/C/D)	Full operating range. Jit- ter performance may be reduced.	24.97	_	54.06	MHz	
		Range for best jitter.	48	—	54	MHz	
	f <sub>XTAL</sub> (P)	±100 ppm crystal	48	—	48	MHz	
Load Capacitance	CL		_	8	_	pF	
Crystal Drive Level	dL		_	_	200	μW	
Equivalent Series Resistance	r <sub>ESR</sub>	Refer to the Si5395-94-92 Family Reference Manual to determine ESR and she capacitance values.					
Shunt Capacitance	Co						

#### Note:

1. Refer to the Si534x/8x/9x Jitter Attenuators Recommended Crystal, TCXO and OCXOs Reference Manual for recommended 48 to 54 MHz crystals.

Table 5.13. Internal Reference Specifications for Grade J/K/L/M/E <sup>1, 2</sup>
---

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Initial Accuracy	_		8	—	+8	ppm
Frequency Characteristics across Temperature	_	Inclusive of temperature range of –40 to 125 °C, aging at 115 °C and reflow	-88	_	+88	ppm
Activity Dip	_	Frequency Perturbations	-2	_	+2	ppm
Overall Accuracy	_	Inclusive of Initial Accura- cy, Frequency Characteristics Across Temperature and Activi- ty Dips (all items listed above)	-98	_	+98	ppm

Note:

1. These devices with integrated reference have been tuned with an internal 48 MHz reference to deliver optimum performance. It is important to note that connecting an external reference to a device that already has an integrated reference is not allowed. Doing so could lead to internal damage to the circuits.

2. Clocks that feature the integrated crystal may require a slightly longer settling time compared to the external crystal device. See the Reference Manual for more details.

### Table 5.14. Thermal Characteristics 44-QFN and 44-LGA (Si5392 and Si5394)

Parameter	Symbol	Test Condition	44-QFN	44-LGA	Unit
Thermal Desistence		Still Air <sup>1, 2</sup>	22.3	25.49	°C/W
Thermal Resistance	θ <sub>JA</sub>	Air Flow 1 m/s <sup>1, 2</sup>	19.4	22.14	°C/W
Junction to Ambient		Air Flow 2 m/s <sup>1, 2</sup>	18.4	21.13	°C/W
Thermal Resistance	θ <sub>JC</sub>		10.9	9.87	°C/W
Junction to Case	0,0		10.9	9.07	0/11
Thermal Resistance	θ <sub>JB</sub>		9.3	9.52	°C/W
Junction to Board	$\Psi_{JB}$		9.2	9.58	°C/W
Thermal Resistance	τ <sub>υ</sub> Ψ		0.23	0.81	°C/W
Junction to Top Center	₽ JT		0.23	0.01	0/00

Note:

1.44-QFN: Based on PCB Dimension: 3" x 4.5" PCB Thickness: 1.6 mm, PCB Land/Via: 36, Number of Cu Layers: 4.

2.44-LGA: Based on 4 layer PCB with dimension 4" x 4.5", PCB Thickness of 1.6 mm, per JEDEC. PCB Center Land with 16 Via to top internal plane of PCB.

### Table 5.15. Thermal Characteristics 64-QFN and 64-LGA (Si5395)

Parameter	Symbol	Test Condition	64-QFN	64-LGA	Unit
		Still Air <sup>1, 2</sup>	22	22.3	°C/W
Thermal Resistance	θ <sub>JA</sub>	Air Flow 1 m/s <sup>1, 2</sup>	19.4	19.4	°C/W
Junction to Ambient		Air Flow 2 m/s <sup>1, 2</sup>	18.3	18.4	°C/W
Thermal Resistance	0		0.5	10.0	°CAN/
Junction to Case	θ <sub>JC</sub>		9.5	10.9	°C/W
Thermal Resistance	θ <sub>JB</sub>		9.4	9.3	°C/W
Junction to Board	Ψ <sub>JB</sub>		9.3	9.2	°C/W
Thermal Resistance			0.0	0.00	°CAN/
Junction to Top Center	Ψ <sub>JT</sub>		0.2	0.23	°C/W

#### Note:

1.64-QFN: Based on PCB Dimension: 3" x 4.5" PCB Thickness: 1.6 mm, PCB Land/Via: 36, Number of Cu Layers: 4.

2.64-LGA: Based on 4 layer PCB with dimension 4" x 4.5", PCB Thickness of 1.6 mm, per JEDEC. PCB Center Land with 16 Via to top internal plane of PCB.

Parameter	Symbol	Test Condition	Value	Unit
	V <sub>DD</sub>		-0.5 to 3.8	V
DC Supply Veltage	V <sub>DDA</sub>		-0.5 to 3.8	V
DC Supply Voltage	V <sub>DDO</sub>		-0.5 to 3.8	V
	V <sub>DDS</sub>		-0.5 to 3.8	V
Input Voltage Range	V <sub>I1</sub> <sup>4</sup>	IN0-IN3/FB_IN	-1.0 to 3.8	V
	V <sub>I2</sub>	IN_SEL1, IN_SEL0, RSTb, OEb, I2C_SEL, FINC, FDEC, SDI, SCLK, A0/CSb, A1, SDA/SDIO	-0.5 to 3.8	V
	V <sub>I3</sub>	XA/XB	-0.5 to 2.7	V
Latch-up Tolerance	LU		JESD78 (	Compliant
ESD Tolerance	HBM	100 pF, 1.5 kΩ	2.0	kV
Storage Temperature Range	T <sub>STG</sub>		–55 to 150	°C
Maximum Junction Temperature in Operation	T <sub>JCT</sub>		125	°C
Soldering Temperature (Pb-free profile) <sup>5</sup>	Треак		260	°C
Soldering Temperature Time at T <sub>PEAK</sub> (Pb-free profile) <sup>5</sup>	T <sub>P</sub>		20–40	S

### Table 5.16. Absolute Maximum Ratings <sup>1, 2, 3</sup>

Note:

1. Permanent device damage may occur if the absolute maximum ratings are exceeded. Functional operation should be restricted to the conditions as specified in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2.64-QFN/LGA and 44-QFN/LGA packages are RoHS compliant.

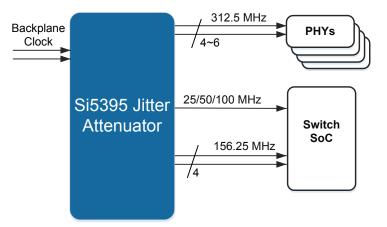
3. For detailed packaging information, go to https://www.skyworksinc.com/.

4. The minimum voltage at these pins can be as low as -1.0 V when an ac input signal of 8 kHz or greater is applied. See Table 5.3 Input Clock Specifications on page 26 for single-ended ac-coupled  $f_{IN}$  < 250 MHz.

5. The device is compliant with JEDEC J-STD-020.

SI5394C-A-GM Skyworks Solutions Inc. SINGLE PLL JITTER ATTENUATOR WIT Si5395/94/92 Data Sheet • Typical Application Schematic

## 6. Typical Application Schematic





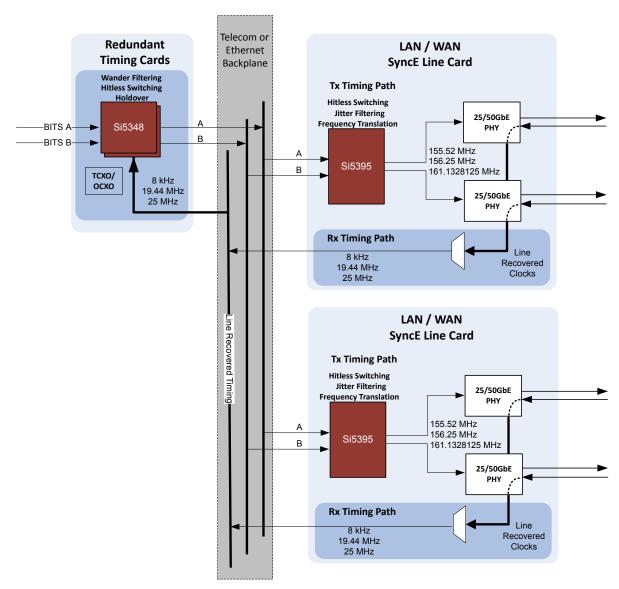


Figure 6.2. SyncE Line Card

## 7. Detailed Block Diagrams

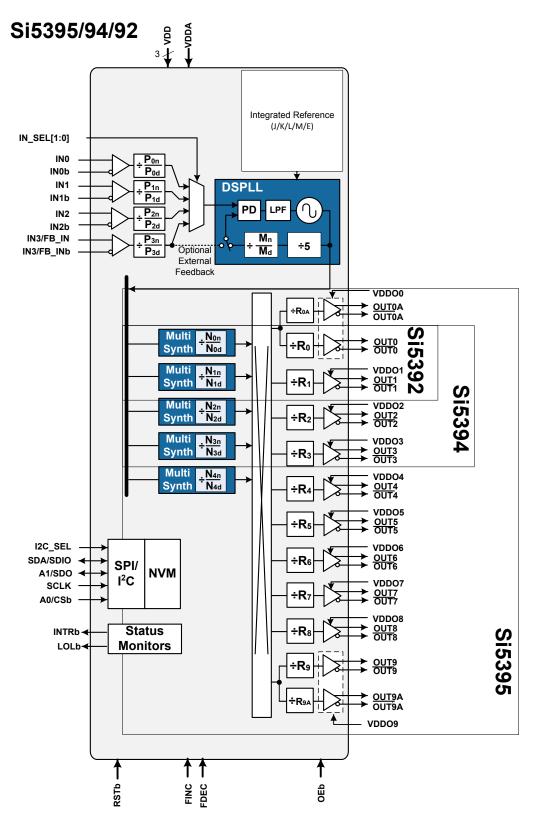


Figure 7.1. Si5392/94/95 Block Diagram

## 8. Typical Operating Characteristics

The phase noise plots below were taken under the following conditions: V<sub>DD</sub> = 1.8 V; V<sub>DDA</sub> = 3.3 V; V<sub>DDS</sub> = 3.3 V, 1.8 V; T<sub>A</sub> = 25 °C.

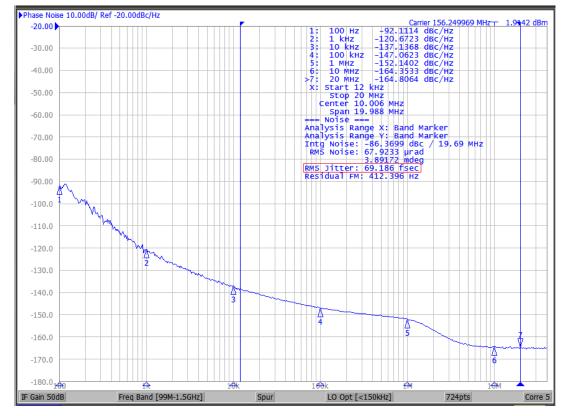


Figure 8.1. Input = 25 MHz; Output = 156.25 MHz, 2.5 V LVDS (Si539x P-Grade)

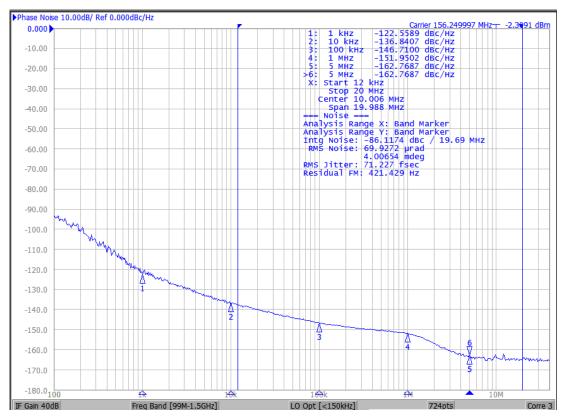


Figure 8.2. Input = 25 MHz; Output = 156.25 MHz, 2.5 V LVDS (Si539x E-Grade)

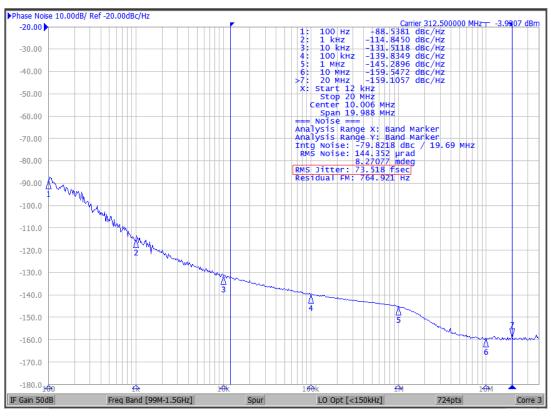


Figure 8.3. Input = 25 MHz; Output = 312.5 MHz, 2.5 V LVDS (Integer Mode)

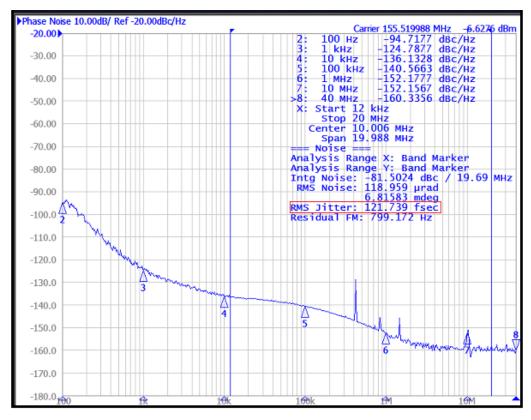
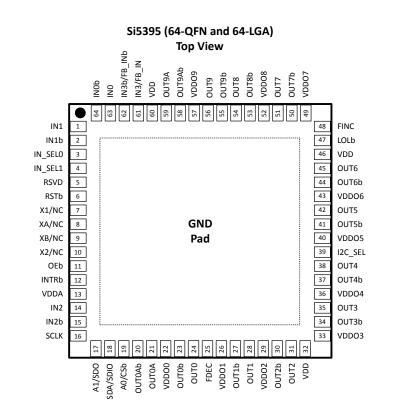
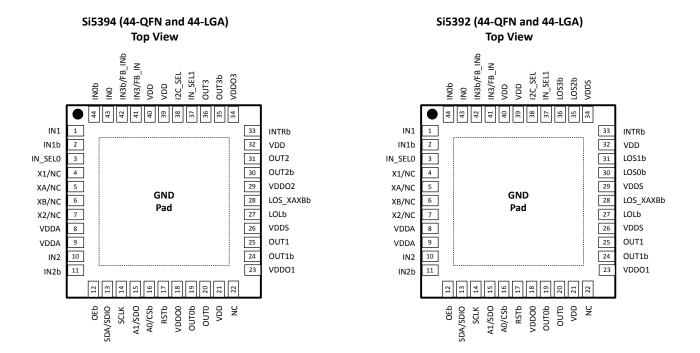


Figure 8.4. Input = 25 MHz; Output = 155.52 MHz, 2.5 V LVDS (Fractional Mode)

SI5394C-A-GM Skyworks Solutions Inc. SINGLE PLL JITTER ATTENUATOR WIT Si5395/94/92 Data Sheet • Pin Descriptions

### 9. Pin Descriptions





**Note:** Grades A/B/C/D require external references so these pins can be connected to those references (XTAL, XO, VCXO, and so on). Note that connecting an external reference to a device that already has an internal reference is not recommended and could lead to internal damage to the circuits.

Din Nomo	Pin Number			<b>- -</b> 1	Eurotion	
Pin Name	Si5395	Si5394	Si5392	Pin Type <sup>1</sup>	Function	
Inputs		1				
XA/NC	8	5	5	I	Crystal Input for Grade A/B/C/D/P. Input pins for external crystal	
					(XTAL). Alternatively these pins can be driven with an external reference clock (REFCLK). An internal register bit selects XTAL or REFCLK mode. Default is XTAL mode.	
XB/NC	9	6	6	1	<b>NC (No-Connect) for Grades J/K/L/M/E.</b> These devices have an integrated reference and these pins cannot be connected to an external reference. They should be left floating to avoid damage or interference to the internal reference.	
X1/NC	7	4	4	I	XTAL Shield for Grade A/B/C/D/P. Connect these pins directly	
					to the XTAL ground pins. X1, X2 and the XTAL ground pins should be separated from the PCB ground plane. Refer to the Si5395-94-92 Family Reference Manual for layout guidelines.	
X2/NC	10	7	7	1	<b>NC (No-Connect) for Grades J/K/L/M/E</b> or external reference clocks. These pins should be left disconnected for Grades J/K/L/M/E with integrated reference or when connecting XA/XB pins to an external reference clock (REFCLK)	
IN0	63	43	43	I		
IN0b	64	44	44	I	<b>Clock Inputs.</b> These pins accept an input clock for synchronizing the device. They support both differential and single-ended clock	
IN1	1	1	1	I	signals. Refer to the Si5395-94-92 Family Reference Manual for input termination options. These pins are high-impedance and	
IN1b	2	2	2	I	must be terminated externally. The negative side of the differen-	
IN2	14	10	10	I	tial input must be grounded through a capacitor when accepting a single-ended clock.	
IN2b	15	11	11	I		
IN3/FB_IN	61	41	41	I	Clock Input 3/External Feedback Input. By default these pins	
IN3b/FB_INb	62	42	42	1	are used as the fourth clock input (IN3/IN3b). They can also be used as the external feedback input (FB_IN/FB_INb) for the optional zero delay mode. See 4.9.13 Zero Delay Mode (Grade A/B/C/D and J/K/L/M) for details on the optional zero delay mode.	

### Table 9.1. Si5395/94/92 Pin Descriptions

		Pin Number		1	
Pin Name	Si5395	Si5394	Si5392	Pin Type <sup>1</sup>	Function
Outputs	I				1
OUT0Ab	20		_	0	
OUT0A	21	_	_	0	
OUT0	24	20	20	0	
OUT0b	23	19	19	0	
OUT1	28	25	25	0	
OUT1b	27	24	24	0	
OUT2	31	31	_	0	
OUT2b	30	30	_	0	
OUT3	35	36	_	0	
OUT3b	34	35	_	0	
OUT4	38		_	0	<b>Output Clocks.</b> These output clocks support a programmable
OUT4b	37		_	0	signal swing and common mode voltage. Desired output signal
OUT5	42		_	0	format is configurable using register control. Termination recom- mendations are provided in the Si5395-94-92 Family Reference
OUT5b	41		_	0	Manual. Unused outputs should be left unconnected.
OUT6	45		_	0	
OUT6b	44	_	_	0	
OUT7	51		_	0	
OUT7b	50		_	0	
OUT8	54	_	_	0	
OUT8b	53	—	_	0	
OUT9	56	—	_	0	
OUT9b	55	_	_	0	]
OUT9A	59	_	_	0	
OUT9Ab	58	—	_	0	
Serial Interfac	ce				
I2C_SEL	39	38	38	I	I <sup>2</sup> C Select <sup>2</sup> . This pin selects the serial interface mode as I <sup>2</sup> C (I2C_SEL = 1) or SPI (I2C_SEL = 0). This pin is internally pulled up by a ~ 20 kΩ resistor to the voltage selected by the IO_VDD_SEL register bit.

### Table 9.2. Si5395/94/92 Pin Descriptions

		Pin Number		<b>-</b> - 1	E. w. atlan
Pin Name	Si5395	Si5394	Si5392	Pin Type <sup>1</sup>	Function
SDA/SDIO	18	13	13	I/O	Serial Data Interface <sup>2</sup> This is the bidirectional data pin (SDA) for the I <sup>2</sup> C mode, or the bidirectional data pin (SDIO) in the 3-wire SPI mode, or the input data pin (SDI) in 4-wire SPI mode. When in I <sup>2</sup> C mode, this pin is an open-drain output and must be pulled up using an external resistor of at least 1 k $\Omega$ . No pull-up resistor is needed when in SPI mode as the output is a push-pull driver. Tie low when unused.
A1/SDO	17	15	15	I/O	Address Select 1/Serial Data Output <sup>2</sup> In I <sup>2</sup> C mode, this pin is open-drain and functions as the A1 ad- dress input pin. It does not have an internal pull-up or pull-down resistor. In 4-wire SPI mode this output is a push-pull driver and functions as the serial data output (SDO) pin. It drives high to the voltage selected by the IO_VDD_SEL bit. Leave disconnected when unused.
SCLK	16	14	14	I	Serial Clock Input <sup>2</sup> This pin functions as the serial clock input for both I <sup>2</sup> C and SPI modes. When in I <sup>2</sup> C mode, this pin must be pulled-up using an external resistor of at least 1 k $\Omega$ . No pull-up resistor is needed when in SPI mode. Tie high or low when unused.
A0/CSb	19	16	16	I	Address Select 0/Chip Select <sup>2</sup> This pin functions as the hardware controlled address A0 in I <sup>2</sup> C mode. In SPI mode, this pin functions as the chip select input (active low). This pin is internally pulled-up by a ~20 k $\Omega$ resistor and can be left unconnected when not in use.
Control/Statu	IS				
INTRb	12	33	33	О	Interrupt <sup>2</sup> This pin is asserted low when a change in device status has occurred. It should be left unconnected when not in use.
RSTb	6	17	17	I	<b>Device Reset<sup>2</sup></b> Active low input that performs power-on reset (POR) of the device. Resets all internal logic to a known state and forces the device registers to their default values. Clock outputs are disabled during reset. This pin is internally pulled-up and can be left unconnected when not in use.
OEb	11	12	12	I	Output Enable <sup>2</sup> This pin disables all outputs when held high. This pin is internally pulled low and can be left unconnected when not in use.
	47	_	_	0	Loss of Lock (Si5395) <sup>2</sup> This output pin indicates when the DSPLL is locked (high) or out-of-lock (low). It can be left unconnected when not in use.
LOLb	_	27	27	0	Loss of Lock (Si5394/92) <sup>3</sup> This output pin indicates when the DSPLL is locked (high) or out-of-lock (low). It can be left unconnected when not in use.

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	Pin Number					
Pin Name	Si5395	Si5394	Si5392	Pin Type <sup>1</sup>	Function	
					Loss of Signal for IN0 <sup>3</sup>	
LOS0b	—	_	30	-	This pin indicate a loss of clock at the IN0 pin when low.	
					Loss of Signal for IN1 <sup>3</sup>	
LOS1b	—	_	31	0	This pin indicate a loss of clock at the IN1 pin when low.	
			0.5		Loss of Signal for IN2 <sup>3</sup>	
LOS2b	_	_	35	0	This pin indicate a loss of clock at the IN2 pin when low.	
1.0001			20	0	Loss of Signal for IN3 <sup>3</sup>	
LOS3b	_	_	36	0	This pin indicate a loss of clock at the IN3 pin when low.	
			20	0	Loss of Signal on XA/XB Pins <sup>3</sup>	
LOS_XAXBb	_	28	28	0	This pin indicates a loss of signal at the XA/XB pins when low.	
					Frequency Increment Pin <sup>2</sup>	
FINC	48	_	_	I	This pin is used to step-up the output frequency of a selected output. The affected output and its frequency change step size is register configurable. This pin is internally pulled low and can be left unconnected when not in use.	
					Frequency Decrement Pin <sup>2</sup>	
FDEC	25	_	_	I	This pin is used to step-down the output frequency of a selected output. The affected output driver and its frequency change step size is register configurable. This pin is internally pulled low and can be left unconnected when not in use.	
IN_SEL0	3	3	3	I	Input Reference Select <sup>2</sup>	
IN_SEL1	4	37	37	I	The IN_SEL[1:0] pins are used in manual pin controlled mode to select the active clock input as shown in Table 4.1 Manual Input Selection Using IN_SEL[1:0] Pins on page 13. These pins are internally pulled low.	
					Reserved	
RSVD	5	_	_	_	These pins are connected to the die. Leave disconnected.	
NC		22	22		No Connect	
NC	—	22	22		These pins are not connected to the die. Leave disconnected.	
Power						
_	32	21	21	Р	Core Supply Voltage	
VDD	46	32	32	Р	The device operates from a 1.8 V supply. A 1.0 $\mu$ F bypass capac-	
	60	39	39	Р	itor should be placed very close to this pin. See the Si5395-94-92 Family Reference Manual for power supply filtering recommenda-	
	—	40	40	Р	tions.	
	13	8	8	Р	Core Supply Voltage 3.3 V	
VDDA	_	9	9	Р	This core supply pin requires a 3.3 V power source. A 1 $\mu$ F bypass capacitor should be placed very close to this pin. See the Si5395-94-92 Family Reference Manual for power supply filtering recommendations.	

Pin Name	Pin Number				Frankton	
Pin Name	Si5395	Si5394	Si5392	Pin Type <sup>1</sup>	Function	
	—	26	26	Р	Status Output Voltage	
	—	_	29	Р	The voltage on this pin determines VOL/VOH on the Si5392/94	
VDDS	_	_	34	Ρ	LOLb and LOL_XAXBb. It also determines the levels on the LOS0b, LOS1b, LOS2b, and LOS3b outputs of the Si5392. Connect to either 3.3 V or 1.8 V. A 1.0 $\mu$ F bypass capacitor should be placed very close to this pin. This voltage must match the IO operating voltage selected for the frequency plan in CBPro.	
VDDO0	22	18	18	Р		
VDDO1	26	23	23	Р		
VDDO2	29	29	—	Р		
VDDO3	33	34	—	Р	Output Clock Supply Voltage	
VDDO4	36	_	—	Р	Supply voltage (3.3 V, 2.5 V, 1.8 V) for OUTn, OUTn outputs. For	
VDDO5	40	_	—	Р	unused outputs, leave VDDO pins unconnected. An alternative option is to connect the VDDO pin to a power supply and disable	
VDDO6	43	_	—	Р	the output driver to minimize current consumption.	
VDDO7	49	_	—	Р		
VDDO8	52	_	—	Р		
VDDO9	57	_	—	Р		
gnd pad	_	_	_	Р	<b>Ground Pad</b> This pad provides connection to ground and must be connected for proper operation. Use as many vias as practical, and keep the via length to an internal ground plane as short as possible.	

### Note:

1. I = Input, O = Output, P = Power.

2. The IO\_VDD\_SEL control bit (0x0943 bit 0) selects 3.3 V or 1.8 V operation.

3. The voltage on the VDDS pin(s) determines 3.3 V or 1.8 V operation.

4. Refer to the Si5395-94-92 Family Reference Manual for more information on register setting names.

5. All status pins except I<sup>2</sup>C and SPI are push-pull.

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### 10. Package Outlines

### 10.1 Si5395 A/B/C/D/P (External Reference) 9x9 mm 64-QFN Package Diagram

The following figure illustrates the package details for the Si5395 A/B/C/D/P. The table lists the values for the dimensions shown in the illustration.

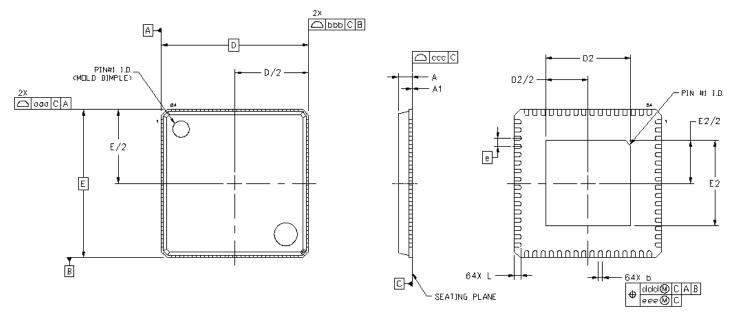


Figure 10.1. 64-Pin Quad Flat No-Lead (QFN)

Dimension	Min	Nom	Мах
A	0.80	0.85	0.90
A1	0.00	0.02	0.05
b	0.18	0.25	0.30
D		9.00 BSC	
D2	5.10	5.20	5.30
e	0.50 BSC		
E		9.00 BSC	
E2	5.10	5.20	5.30
L	0.30	0.40	0.50
ааа	—	_	0.10
bbb	_	—	0.10
CCC	—	_	0.08
ddd	_		0.10

### Table 10.1. Package Dimensions

#### Note:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.

2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.

3. This drawing conforms to the JEDEC Solid State Outline MO-220.

4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

SI5394C-A-GM Skyworks Solutions Inc. SINGLE PLL JITTER ATTENUATOR WIT Si5395/94/92 Data Sheet • Package Outlines

### 10.2 Si5395 J/K/L/M/E (Internal Reference) 9x9 mm 64-LGA Package Diagram

The following figure illustrates the package details for the Si5395 J/K/L/M/E. The table lists the values for the dimensions shown in the illustration.

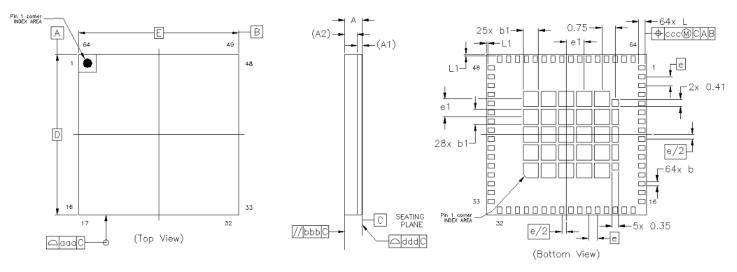


Figure 10.2. 64-Pin LGA

Table 10.2. Package Dimensions

Dimension	Min	Nom	Мах	
A	0.9	1	1.1	
A1		0.26 REF		
A2		0.70 REF		
b	0.2	0.25	0.3	
b1	0.8	0.85	0.9	
D	9 BSC			
E	9 BSC			
е	0.5 BSC			
e1		1.0 BSC		
L	0.315	0.365	0.415	
L1	0.080 REF			
ааа	0.1			
bbb	0.2			
CCC	0.1			
ddd		0.08		

#### Note:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.

2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.

3. This drawing conforms to the JEDEC Solid State Outline MO-220.

4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

SI5394C-A-GM Skyworks Solutions Inc. SINGLE PLL JITTER ATTENUATOR WIT Si5395/94/92 Data Sheet • Package Outlines

#### 10.3 Si5394 and Si5392 A/B/C/D/P (External Reference) 7x7 mm 44-QFN Package Diagram

The following figure illustrates the package details for the Si5394 and Si5392. The table lists the values for the dimensions shown in the illustration.

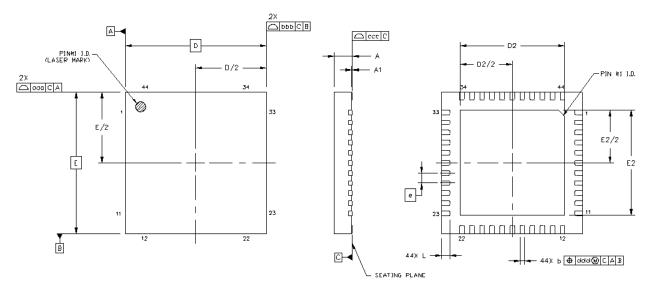


Figure 10.3. 44-Pin Quad Flat No-Lead (QFN)

Dimension	Min	Nom	Мах	
A	0.80	0.85	0.90	
A1	0.00	0.02	0.05	
b	0.18	0.25	0.30	
D		7.00 BSC		
D2	5.10	5.20	5.30	
e	0.50 BSC			
E	7.00 BSC			
E2	5.10	5.20	5.30	
L	0.30	0.40	0.50	
ааа	_	—	0.10	
bbb	—	—	0.10	
CCC	_	—	0.08	
ddd	_	_	0.10	

#### Table 10.3. Package Dimensions

#### Note:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.

2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.

3. This drawing conforms to the JEDEC Solid State Outline MO-220.

4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

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### 10.4 Si5394 and Si5392 J/K/L/M/E (Internal Reference) 7x7 mm 44-LGA Package Diagram

The following figure illustrates the package details for the Si5394J and Si5392J. The table lists the values for the dimensions shown in the illustration.

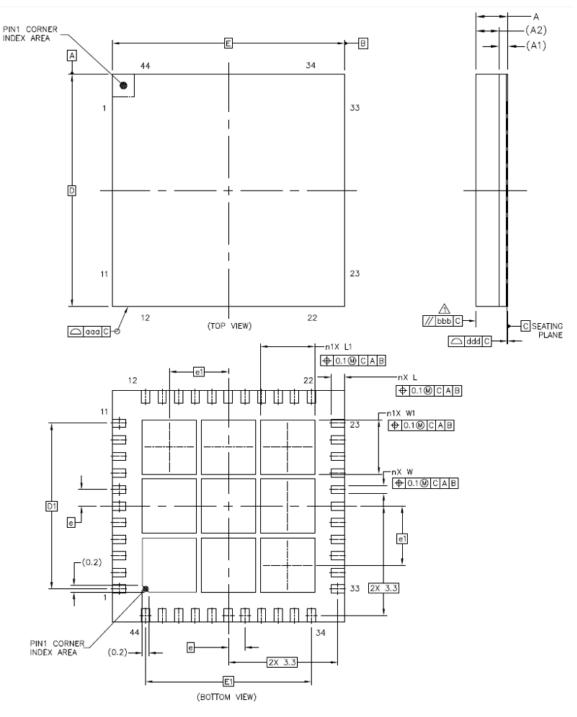


Figure 10.4. 44-Pin LGA

## Table 10.4. Package Dimensions

Dimension	Min	Nom	Мах	
A	_	_	1.1	
A1		0.26 REF		
A2		0.7 REF		
D		7 BSC		
E		7 BSC		
W	0.2	0.25	0.3	
L	0.35	0.4	0.45	
е	0.5 BSC			
n	44			
D1	5 BSC			
E1		5 BSC		
W1	1.5833	1.6333	1.6833	
L1	1.5833	1.6333	1.6833	
e1		1.7833		
n1	9			
ааа	0.1			
bbb	0.2			
ddd		0.08		
Note:	1			

1. The dimensions in parenthesis are reference.

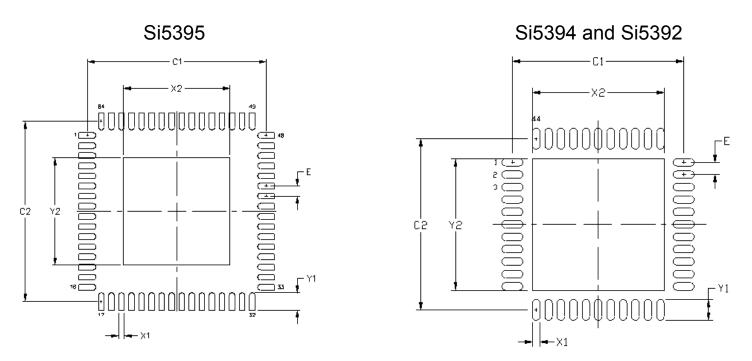
2. All dimensions in millimeters (mm).

3. Dimensioning and Tolerance per ANSI Y14.5M-1994.

SI5394C-A-GM Skyworks Solutions Inc. SINGLE PLL JITTER ATTENUATOR WIT Si5395/94/92 Data Sheet • PCB Land Pattern

## 11. PCB Land Pattern

The following figure illustrates the PCB land pattern details for the devices. The table lists the values for the dimensions shown in the illustration.





### Table 11.1. PCB Land Pattern Dimensions

Dimension	Si5395 (Max)	Si5394/92 (Max)
C1	8.90	6.90
C2	8.90	6.90
E	0.50	0.50
X1	0.30	0.30
Y1	0.85	0.85
X2	5.30	5.30
Y2	5.30	5.30

#### Notes:

#### General

1. All dimensions shown are in millimeters (mm) unless otherwise noted.

2. This Land Pattern Design is based on the IPC-7351 guidelines.

3. All dimensions shown are at Maximum Material Condition (MMC). Least Material Condition is calculated based on a fabrication Allowance of 0.05 mm.

#### Solder Mask Design

1. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 µm minimum, all the way around the pad.

#### Stencil Design

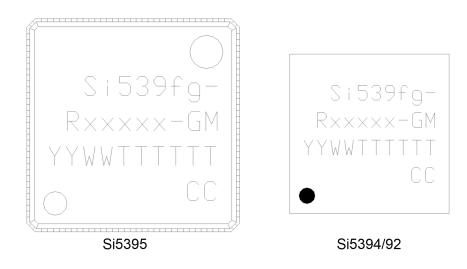
1. A stainless steel, laser-cut and electropolished stencil with trapezoidal walls should be used to assure good solder paste release.

- 2. The stencil thickness should be 0.125 mm (5 mils).
- 3. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pads.
- 4. The stencil design will need to match the respective ground pads as shown in the Package outline. The stencil aperture to land pad size recommendation is 70% paste coverage.

### Card Assembly

- 1. A No-Clean, Type-3 solder paste is recommended.
- 2. The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

## 12. Top Marking





Line	Characters	Description
		Base part number and Device Grade for Any-frequency, Any-output, Jitter Cleaning Clock (single PLL):
		f = 5: 12-output Si5395
1	Si539fa-	f = 4: 4-output Si5394
	000019-	f = 2: 2-output Si5392
		g = Device Grade (A/B/C/D/P/J/K/L/M/E). See 3. Ordering Guide for more information.
		– = Dash character.
		R = Product revision. (Refer to 3. Ordering Guide for latest revision).
2	Rxxxx-GM	xxxxx = Customer specific NVM sequence number. Optional NVM code as- signed for custom, factory pre-programmed devices.
2		Characters are not included for standard, factory default configured devices. See 3. Ordering Guide for more information.
		-GM = Package (QFN/LGA) and temperature range (–40 to +85 °C)
3	YYWWTTTTTT	YYWW = Characters correspond to the year (YY) and work week (WW) of package assembly.
		TTTTTT = Manufacturing trace code.
4	Circle w/ 1.6 mm (64-QFN) or 1.4 mm (44-QFN) diameter	Pin 1 indicator; left-justified
	CC	CC = TW = Taiwan; Country of Origin (ISO Abbreviation)

## 13. Revision History

### **Revision 1.2**

July, 2020

- The single center pad on the 7x7 mm 44-LGA Package is divided by soldermask into nine pads (3x3 grid array) to increase mechanical support to the center of the package; there is no change to the PCB layout made or to any of the metal layers of the package.
- · Zero-delay mode is specified only for A/B/C/D and J/K/L/M.
- Updated Output Dynamic Delay Adjustment specification by combining fractional and integer specs into a single delay spec.

### **Revision 1.1**

June, 2019

Added Integrated reference options J/K/L/M/E.

### Revision 1.0

April, 2019

- Updated Figure 4.3. Crystal Resonator and External Reference Clock Connection Options
- Updated section 4.9.2 Grade P section to support up to 3 time domains for Si5395, 2 domains for Si5394 and 1 domain for Si5392 (previous version only specified 2 domains for Si5395)
- Table 5.2 DC Characteristics
  - · Core supply current IDD/IDDA limits clarified for each device
  - · Output Buffer supply conditions clarified
  - · Total power dissipation numbers updated
  - · Updated test configuration diagrams
- Table 5.3 Input clock specifications
  - · Updated Input voltage section of "LVCMOS / Pulsed CMOS DC-Coupled Input Buffer" to include standard CMOS
- Table 5.5 Differential Clock Output Specifications
  - Clarified duty cycle specs for when MultiSynth is used/not used
  - Increased max Rise and Fall times from 150ps to 200ps based on final characterization
- Table 5.6. LVCMOS Clock Output Specifications
  - Updated Min and Max limits for duty cycle
  - Updated test configuration diagrams
- Table 5.8. Performance Characteristics
  - Updated Initial startup time for P-grade devices
  - · Updated P-grade jitter numbers to include more domains and finalize test conditions
- Updated Table 5.10. SPI Timing Specifications (4-Wire) table and timing diagram
- Updated Table 5.11. SPI Timing Specifications (3-Wire)
- Changed NC/XA, NC/XB, NC/X1, NC/X2 to XA, XB, X1, X2 respectively since integrated crystal devices are getting their own data sheet

### Revision 0.96

June, 2018

· Preliminary data sheet.



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